

# MOS INTEGRATED CIRCUIT $\mu$ PD784915A, 784916A

# 16-BIT SINGLE-CHIP MICROCONTROLLERS

#### **DESCRIPTION**

The  $\mu$ PD784915A, 784916A are members of the NEC 78K/IV Series of microcontrollers equipped with a high-speed 16-bit CPU and are the successors of the 78K/I Series 8-bit single-chip microcontrollers for VCR software servo control.

This series contains many peripheral hardware units ideal for VCR control, such as a multi-function timer unit (super timer unit) suitable for software servo control and VCR analog circuits.

A one-time PROM version of the  $\mu$ PD784916A, the  $\mu$ PD78P4916, is also available.

The functions of the  $\mu$ PD784916A are described in detail in the following user's manuals. Be sure to read them before designing.

 $\mu$ PD784915 Subseries User's Manual - Hardware: U10444E 78K/IV Series User's Manual - Instruction: U10905E

#### **FEATURES**

- High instruction execution speed realized by 16-bit CPU core
  - Minimum instruction execution time: 250 ns (with 8-MHz internal clock)
- High internal memory capacity

Part Number	ROM	RAM
μPD784915A	48 Kbytes	1280 bytes
μPD784916A	62 Kbytes	

- VCR analog circuits conforming to VHS Standard
  - · CTL amplifier
  - · RECCTL driver (rewritable)
  - CFG amplifier
  - DFG amplifier
  - DPG comparator
  - DPFG separation circuit (ternary separation circuit)
  - Reel FG comparator (2 channels)
  - · CSYNC comparator
- · Timer unit (super timer unit) for servo control
- Serial interface: 2 channels (3-wire serial I/O)
- A/D converter: 12 channels (conversion time: 10  $\mu$ s)
- · Low-frequency oscillation mode: main system clock frequency = internal clock frequency
- Low-power dissipation mode: CPU can operate with a subsystem clock.
- Supply voltage range: VDD = 2.7 to 5.5 V
- Hardware watch function: watch operation at low voltage (VDD = 2.7 V (MIN.)) and low current

#### **APPLICATIONS**

Control system/servo/timer of VCR

Unless mentioned otherwise, the  $\mu$ PD784916A is described as the representative product. The information in this document is subject to change without notice



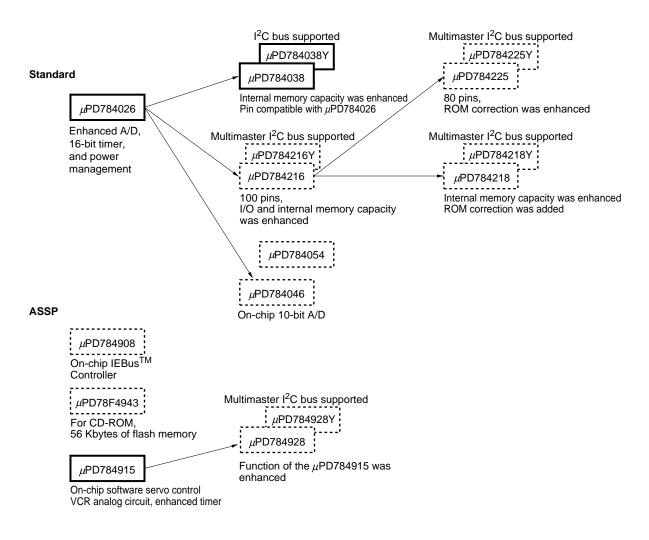
#### ORDERING INFORMATION

	Part Number	Package
*	μPD784915AGF-xxx-3BA	100-pin plastic QFP (14 x 20 mm)
	$\mu$ PD784916AGF-xxx-3BA	100-pin plastic QFP (14 x 20 mm)

Remark xxx indicates a ROM code number.

# ★ Product Development of 78K/IV Series

: Under mass production





# Function List (1/2)

	Item	иРГ	)784915A		μPD784916A	
Internal ROM capacity		48 Kbytes 64 Kbytes				
<b>——</b>	I RAM capacity					
	ing clock	16 MHz (interna	l clock: 8 MHz)			
Operali	ing older.	,	scillation mode: 8 N	//Hz (internal clock:	8 MHz)	
			pation mode: 32.768	•	· ·	
Minimu	m instruction ex-	-	1Hz internal system		, , , , , , , , , , , , , , , , , , ,	
ecution		200 110 (With 0 1)	ii iz iiitoiiiai oyotoiii	olook)		
I/O port		input: 8				
,, o por	.0	54				
Real-tin	ne output port	11 (including on	e each for nseudo	Veyno head amplif	ier switch, and chromi	nance
Nour til	no output port	rotation)	c cach for pacado	varne, nead ampin	ici switch, and chronin	larioc
	Timer/counter	Timer/counter	Compare register	Capture register	Remark	
	Timon oddinor	TM0 (16 bits)	3	-	Roman	
		TM1 (16 bits)	3	1		
		FRC (22 bits)	_	6		
		TM3 (16 bits)	2	1		
		UDC (5 bits)	1	· _		
		EC (8 bits)	4	- F	or HSW signal generat	tion
		EDV (8 bits)	1	_	For CFG signal division	
	Capture register	Input signal	Number of bits	Measurable cycle	Operating edge	
	captains regions	CFG	22	125 ns to 524 ms	<u> </u>	
		DFG	22	125 ns to 524 ms	<b>↑</b>	
		HSW	16	1 $\mu$ s to 65.5 ms	$\uparrow$ $\downarrow$	
Super		Vsync	22	125 ns to 524 ms	<b>↑</b>	
timer		CTL	16	1 μs to 65.5 ms	$\uparrow$ $\downarrow$	
unit		TREEL	22	125 ns to 524 ms	$\uparrow$ $\downarrow$	
		SREEL	22	125 ns to 524 ms	$\uparrow$ $\downarrow$	
	VCR special circuit	Vsync separati	on circuit, Hsync se	paration circuit		
	·	VISS detection	n, wide aspect detec	ction circuits		
		Field identification	tion circuit			
		Head amplifier switch/chroma rotation output circuit				
	General-purpose					
	timer	TM2 (16 bits) 1 –				
TM4 (16 bits) 1 (capture/compare) TM5 (16 bits) 1				1		
					_	
	PWM output	16-bit accurac	y: 3 channels (carr	ier frequency: 62.5	kHz)	
8-bit accuracy : 3 channels (carrier frequency: 62.5 kHz)					kHz)	
Serial i	nterface	3-wire serial I/O:	2 channels	-		
		BUSY/STRB control (1 channel only)				
A/D cor	nverter	8-bit resolution x 12 channels, conversion time: 10 $\mu$ s				



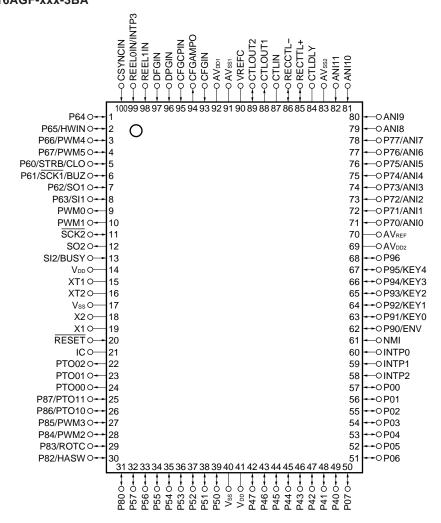
# Function List (2/2)

Item	μPD784915A	μPD784916A		
Analog circuit	CTL amplifier			
RECCTL driver (rewritable)				
	DFG amplifier, DPG comparator, CFG a	amplifier		
	DPFG separation circuit (ternary separation)	ation circuit)		
	Reel FG comparator (2 channels)			
Interrupt	4 levels (programmable), vector interrupt, macro service, context switching			
External	9 (including NMI)			
Internal	19 (including software interrupt)			
Standby function HALT/STOP mode/low power dissipation mode/low power dissipation HALT		mode/low power dissipation HALT mode		
	STOP mode can be released by input of val	lid edge of NMI pin, watch interrupt (INTW),		
	or INTP1/INTP2/KEY0-KEY4 pins			
Watch function	function 0.5-second measurement, low-voltage operation (VDD = 2.7 V)			
Supply voltage	V <sub>DD</sub> = 2.7 to 5.5 V			
Package	100-pin plastic QFP (14 x 20 mm)			

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#### PIN CONFIGURATION (Top View)

• 100-pin plastic QFP (14 x 20 mm) μPD784915AGF-xxx-3BA μPD784916AGF-xxx-3BA



Caution Directly connect the IC (Internally Connected) pins to Vss.



ANIO-ANI11 : Analog Input P00-P07 : Port0 AVDD1, AVDD2 : Analog Power Supply P40-P47 : Port4 AVss<sub>1</sub>, AVss<sub>2</sub> : Analog Ground P50-P57 : Port5 : Analog Reference Voltage **AV**REF P60-P67 : Port6 **BUSY** : Serial Busy P70-P77 : Port7 BUZ : Buzzer Output P80, P82-P87 : Port8 : Capstan FG Amplifier Output **CFGAMPO** P90-P96 : Port9

CFGCPIN : Capstan FG Capacitor Input PTO00-PTO02 : Programmable Timer Output

CFGIN : Analog Unit Input PTO10, PTO11

CLO : Clock Output PWM0-PWM5 : Pulse Width Modulation Output CSYNCIN : Analog Unit Input RECCTL+, RECCTL- : RECCTL Output/PBCLT Input

CTLDLY : Control Delay Input REEL0IN, REEL1IN : Analog Unit Input

CTLIN : CTL Amplifier Input Capacitor RESET : Reset

CTLOUT1, CTLOUT2: CTL Amplifier Output ROTC: Chrominance Rotate Output

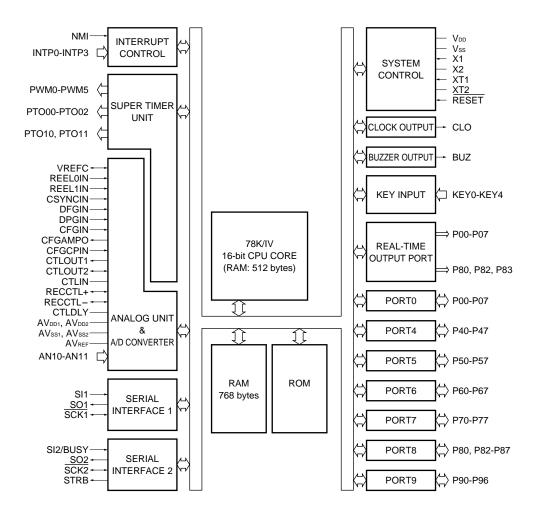
SCK1, SCK2 **DFGIN** : Analog Unit Input : Serial Clock **DPGIN** : Analog Unit Input SI1, SI2 : Serial Input ENV : Envelope Input SO1, SO2 : Serial Output : Head Amplifier Switch Output **STRB** : Serial Strobe **HASW HWIN** : Hardware Timer External Input : Power Supply VDD

IC : Internally Connected VREFC : Reference Amplifier Capacitor

INTP0-INTP3 : Interrupt From Peripherals Vss : Ground

KEY0-KEY4 : Key Return X1, X2 : Crystal (Main System Clock)
NMI : Nonmaskable Interrupt XT1, XT2 : Crystal (Subsystem Clock)

#### INTERNAL BLOCK DIAGRAM

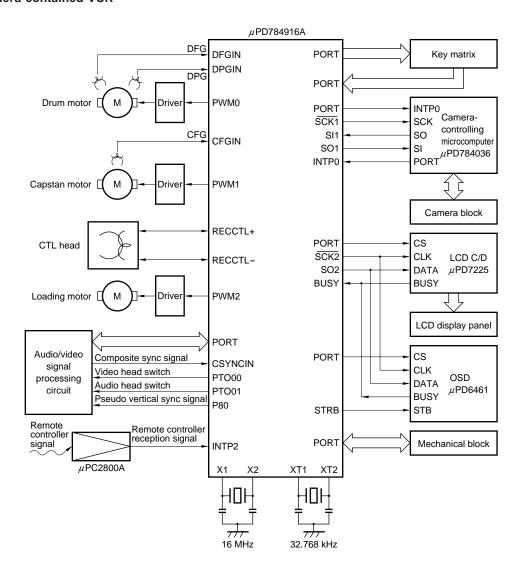


**Remark** Internal ROM capacity varies depending on the part number.

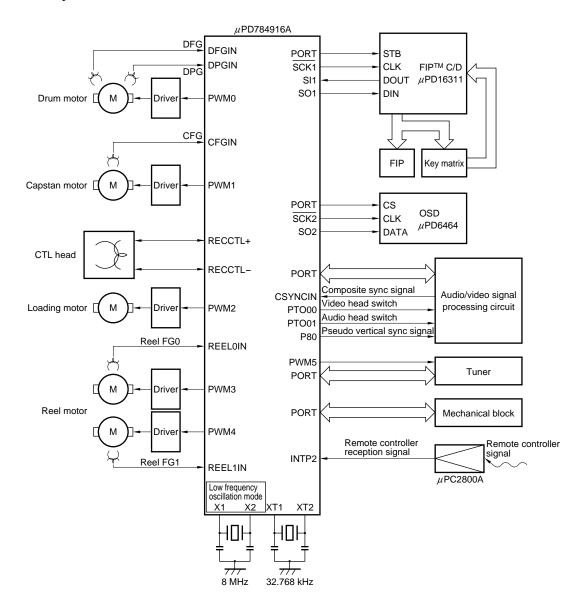


#### SYSTEM CONFIGURATION EXAMPLE

# • Camera-contained VCR



#### Stationary VCR



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# $\star$ 1. DIFFERENCES AMONG $\mu$ PD784915 SUBSERIES PRODUCTS

The  $\mu$ PD784915 subseries comprises the four products shown in Table 1-1. The  $\mu$ PD784915A, which is a process-shrinked version of the  $\mu$ PD784915 is a low-cost product. The  $\mu$ PD784916A is a version of the  $\mu$ PD784915 with internal ROM extended to 62K bytes. The  $\mu$ PD78P4916 is a product with the mask ROM of the  $\mu$ PD784915, 784915A, and 784916A replaced by a writable one-time PROM. Therefore, it has the same functions as those of the  $\mu$ PD784915, 784915A and 784916A, with only exception that it has PROM for internal ROM and a different capacity.

Before using the PROM to perform debugging or preproduction of an application system and then using the mask ROM to proceed with volume production, etc., thoroughly check the differences between these products.

For more information about the CPU functions and on-chip hardware, see  $\mu$ PD784915 Subseries User's Manual - Hardware (U10444E).

Table 1-1. Differences among  $\mu$ PD784915 Subseries Products

Item	μPD784915, 784915A	μPD784916A	μPD78P4916		
Internal ROM	Mask ROM	Mask ROM	One-time PROM		
	48K bytes	62K bytes	62K bytes <sup>Note</sup>		
Internal RAM	1280 bytes	1280 bytes	2048 bytes <sup>Note</sup>		
Internal memory capacity select register (IMS)	Not available	Not available	Available		
Pin connections	The μPD78P4916 has additional PROM write/read related				
	pin functions.				
Other	Since these products are different in circuit scale and mask				
	layout, they partly differ in noise resistance, noise radiation				
	and electrical specifications.				

**Note** The internal PROM and internal RAM capacities can be changed by the internal memory capacity select register (IMS).

Caution The PROM version and mask ROM version differ in noise immunity and noise radiation, etc.

When considering replacing a PROM product with a mask ROM product when switching from preproduction to volume production, perform sufficient evaluation using a CS version (not ES version) of the mask ROM product.



# 2. PIN FUNCTIONS

# 2.1 Port Pins

Pin Name	I/O	Alternate Function	Function		
P00-P07	I/O	Real-time	8-bit I/O port (port 0).		
		output port	Can be set in input or output mode in 1-bit units.		
			• Can be connected with software pull-up resistors (P00-P07).		
P40-P47	I/O	-	8-bit I/O port (port 4).		
			Can be set in input o	r output mode in 1-bit units.	
			Can be connected wi	th software pull-up resistors (P40-P47).	
P50-P57	I/O	_	8-bit I/O port (port 5).		
			Can be set in input o	r output mode in 1-bit units.	
			Can be connected wi	th software pull-up resistors (P50-P57).	
P60	I/O	STRB/CLO	8-bit I/O port (port 6).		
P61		SCK1/BUZ	Can be set in input o	r output mode in 1-bit units.	
P62		SO1	Can be connected wi	th software pull-up resistors (P60-P67).	
P63		SI1			
P64		_			
P65		HWIN			
P66		PWM4			
P67		PWM5			
P70-P77	Input	ANI0-ANI7	8-bit input port (port 7)		
P80	I/O	Real-time	Pseudo Vsync output	7-bit I/O port (port 8).	
P82		output port	HASW output	Can be set in input or output mode in	
				1-bit units.	
P83			ROTC output	Can be connected with software pull-	
				up resistors (P80, P82-P87).	
P84		PWM2			
P85		PWM3			
P86		PTO10			
P87		PTO11			
P90	I/O	ENV	7-bit I/O port (port 9).		
P91-P95		KEY0-KEY4	Can be set in input or output mode in 1-bit units.		
P96		_	Can be connected with software pull-up resistors (P90-P96).		



# 2.2 Pins Other Than Port Pins (1/2)

Pin Name	I/O	Alternate Function	Function
REEL0IN	Input	INTP3	Reel FG input
REEL1IN		_	
DFGIN		_	Drum FG, PFG input (ternary)
DPGIN		_	Drum PG input
CFGIN		_	Capstan FG input
CSYNCIN		_	Composite SYNC input
CFGCPIN		_	CFG comparator input
CFGAMPO	Output	_	CFG amplifier output
PTO00	Output	_	Programmable timer output of super timer unit
PTO01		_	
PTO02		_	
PTO10		P86	
PTO11		P87	
PWM0	Output	_	PWM output of super timer unit
PWM1		_	
PWM2		P84	
PWM3		P85	
PWM4		P66	
PWM5		P67	
HASW	Output	P82	Head amplifier switch signal output
ROTC	Output	P83	Chroma rotation signal output
ENV	Input	P90	Envelope signal input
SI1	Input	P63	Serial data input (serial interface channel 1)
SO1	Output	P62	Serial data output (serial interface channel 1)
SCK1	I/O	P61/BUZ	Serial clock I/O (serial interface channel 1)
SI2	Input	BUSY	Serial data input (serial interface channel 2)
SO2	Output	_	Serial data output (serial interface channel 2)
SCK2	I/O	_	Serial clock I/O (serial interface channel 2)
BUSY	Input	SI2	Serial busy signal input (serial interface channel 2)
STRB	Output	P60/CLO	Serial strobe signal output (serial interface channel 2)
ANI0-ANI7	Analog input	P70-P77	Analog signal input of A/D converter
ANI8-ANI11		_	
CTLIN	-	_	CTL amplifier input capacitor connection
CTLOUT1	Output	_	CTL amplifier output
CTLOUT2	I/O	_	Logic signal input/CTL amplifier output
RECCTL+, RECCTL-	I/O	_	RECCTL signal output/PBCTL signal input
CTLDLY	-	_	External time constant connection (for RECCTL rewriting)
VREFC	-	-	VREF amplifier AC connection
NMI	Input	-	Non-maskable interrupt request input
INTP0-INTP2	Input	_	External interrupt request input
INTP3	Input	REEL0IN	
KEY0-KEY4	Input	P91-P95	Key input signal input
CLO	Output	P60/STRB	Clock output
BUZ	Output	P61/SCK1	Buzzer output



# 2.2 Pins Other Than Port Pins (2/2)

Pin Name	I/O	Alternate Function	Function
HWIN	Input	P65	External input of hardware watch counter
RESET	Input	_	Reset input
X1	Input	-	Crystal connection for main system clock oscillation
X2	_		
XT1	Input	-	Crystal connection for subsystem clock oscillation.
XT2	_		Crystal connection for watch clock oscillation
AVDD1, AVDD2	-	-	Positive power supply to analog circuits
AVss1, AVss2	_	_	GND of analog circuits
AVREF	-	-	Reference voltage input to A/D converter
V <sub>DD</sub>	-	-	Positive power supply to digital circuits
Vss	_	_	GND of digital circuits
IC	-	-	Internally connected. Directly connect this pin to Vss.

# 2.3 I/O Circuits and Connection of Unused Pins

Table 2-1 shows the I/O circuit type of each pin and the recommended connection of unused pins. For the configuration of each type of I/O circuit, refer to Figure 2-1.

Table 2-1. I/O Circuit Type of each Pin and Recommended Connection of Unused Pins (1/2)

Pin	I/O Circuit Type	I/O	Recommended Connection of Unused Pins
P00-P07	5-A	I/O	Input: Connect to VDD
P40-P47			Output: Open
P50-P57			
P60/STRB/CLO			
P61/SCK1/BUZ	8-A		
P62/SO1	5-A		
P63/SI1	8-A		
P64	5-A		
P65/HWIN	8-A		
P66/PWM4	5-A		
P67/PWM5			
P70/ANI0-P77/ANI7	9	Input	Connect to Vss
P80	5-A	I/O	Input: Connect to VDD
P82/HASW			Output: Open
P83/ROTC			
P84/PWM2			
P85/PWM3			
P86/PTO10			
P87/PTO11			
P90/ENV			
P91/KEY0-P95/KEY4	8-A		
P96	5-A		
SI2/BUSY	2-A	Input	Connect to VDD
SO2	4	Output	Hi-Z: Connect to Vss via pull-down resistor
			Others: Open
SCK2	8-A	I/O	Input: Connect to VDD
			Output: Open
ANI8-ANI11	7	Input	Connect to Vss
RECCTL+, RECCTL-	-	I/O	When ENCTL = 0 and ENREC = 0: Connect to Vss

Remark ENCTL: bit 1 of amplifier control register (AMPC)

ENREC: bit 7 of amplifier mode register 0 (AMPM0)



Table 2-1. I/O Circuit Type of each Pin and Recommended Connection of Unused Pins (2/2)

Pin	I/O Circuit Type	I/O	Recommended Connection of Unused Pins
DFGIN	-	Input	When ENDRUM = 0: Connect to Vss
DPGIN			When ENDRUM = 0 or ENDRUM = 1 and SELPGSEPA
			= 0: Connect to Vss
CFGIN, CFGCPIN			When ENCAP = 0: Connect to Vss
CSYNCIN			When ENCSYN = 0: Connect to Vss
REEL0IN/INTP3, REEL1IN			When ENREEL = 0: Connect to Vss
CTLOUT1	-	Output	Open
CTLOUT2	_	I/O	When ENCTL = 0 and ENCOMP = 0: Connect to Vss
			When ENCTL = 1: Open
CFGAMPO	-	Output	Open
CTLIN	_	-	When ENCTL = 0: Open
VREFC			When ENCTL = 0 and ENCAP = 0 and ENCOMP =
			0: Open
CTLDLY			Open
PWM0, PWM1	3	Output	Open
PTO00-PTO02			
NMI	2	Input	Connect to VDD
INTP0			Connect to VDD or Vss
INTP1, INTP2	2-A	Input	Connect to VDD
AVDD1, AVDD2	_	-	Connect to VDD
AVREF, AVSS1, AVSS2			Connect to Vss
RESET	2	-	-
XT1	_	_	Connect to Vss
XT2			Open
IC			Directly connect to Vss

Remark ENDRUM : bit 2 of amplifier control register (AMPC)

SELPGSEPA: bit 2 of amplifier mode register 0 (AMPM0)

ENCAP : bit 3 of amplifier control register (AMPC)

ENCSYN : bit 5 of amplifier control register (AMPC)

ENREEL : bit 6 of amplifier control register (AMPC)

ENCTL : bit 1 of amplifier control register (AMPC)

ENCOMP : bit 4 of amplifier control register (AMPC)

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Figure 2-1. I/O Circuits of Pins (1/2)

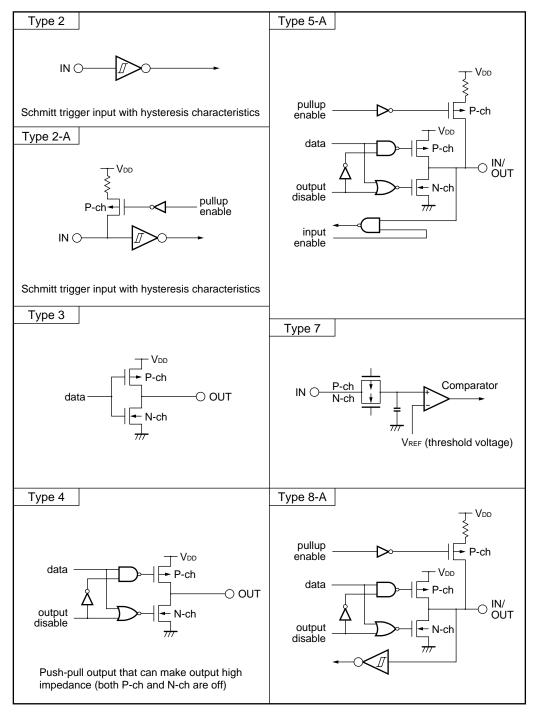
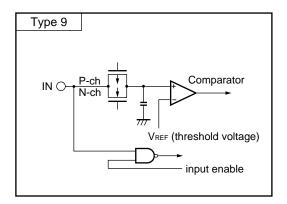


Figure 2-1. I/O Circuits of Pins (2/2)



#### 3. INTERNAL BLOCK FUNCTIONS

#### 3.1 CPU Registers

#### 3.1.1 General-purpose registers

The  $\mu$ PD784916A has eight banks of general-purpose registers. One bank consists of sixteen 8-bit general-purpose registers. Two of these 8-bit registers can be used in pairs as a 16-bit register. Four of the 16-bit general-purpose registers can be used to specify a 24-bit address in combination with an 8-bit address expansion register.

These eight banks of general-purpose registers can be selected by software or context switching function.

The general-purpose registers, except for the address expansion registers V, U, T, and W, are mapped to the internal RAM.

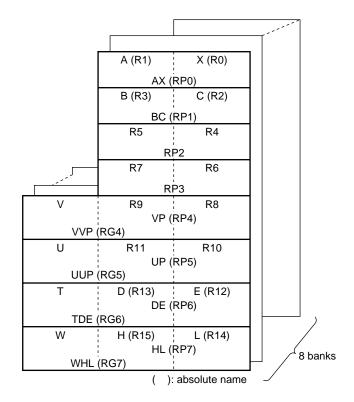


Figure 3-1. Configuration of General-Purpose Registers

Caution Although R4, R5, R6, R7, RP2, and RP3 can be used as X, A, C, B, AX, and BC registers, respectively, by setting the RSS bit of PSW to 1, do not use this function. The function of the RSS bit is planned to be deleted from the future models in the 78K/IV Series.



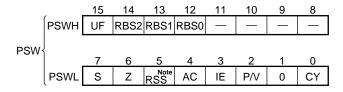
#### 3.1.2 Other CPU registers

#### (1) Program counter

The program counter of the  $\mu$ PD784916A is 20 bits wide. The value of the program counter is automatically updated as the program is executed.

#### (2) Program status word

This is a register that holds the various statuses of the CPU. Its contents are automatically updated as the program is executed.



**Note** The RSS flag is provided to maintain compatibility with the microcomputers in the 78K/III Series. Always clear this flag to 0 except when the software of the 78K/III Series is used.

## (3) Stack pointer

This is a 24-bit pointer that holds the first address of the stack.

Be sure to write 0 to the higher 4 bits.



## 3.2 Memory Space

The  $\mu$ PD784916A can access a 64K-byte memory space.

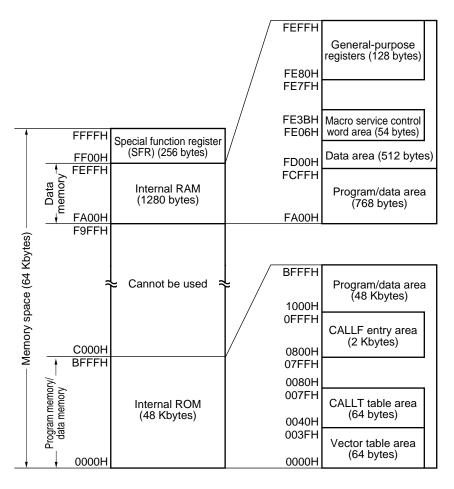
The addresses of the internal ROM and internal data areas are as follows:

Table 3-1. Memory Space

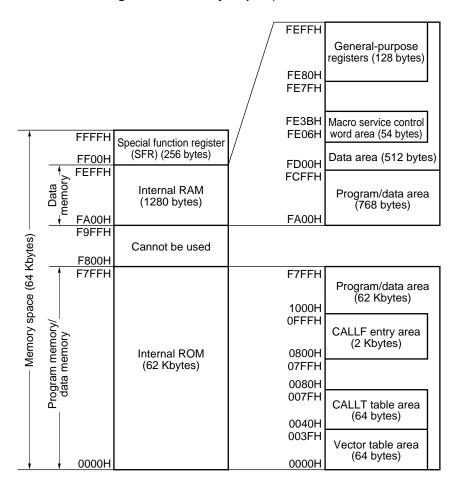
Part Number	Internal ROM Area	Internal Data Area
μPD784915A	0000H-BFFFH	FA00H-FFFFH
μPD784916A	0000H-F7FFH	

Caution Some products in the 78K/IV Series can access up to 1 Mbyte of memory space in an address expansion mode which is set by the LOCATION instruction. However, the memory space of the  $\mu$ PD784916A is 64K bytes (0000H through FFFFH). Therefore, be sure to execute the LOCATION 0 instruction immediately after reset to set the memory space to 64 Kbytes (the LOCATION instruction cannot be used more than once).

Figure 3-2. Memory Map of  $\mu$ PD784915A



#### Figure 3-3. Memory Map of $\mu$ PD784916A



#### 3.3 Special Function Registers (SFRs)

Special function registers are assigned special functions and mapped to a 256-byte space from addresses FF00H through FFFFH. These registers include mode registers and control registers that control the internal peripheral hardware units.

Caution Do not access an address to which no SFR is assigned. If such an address is accessed by mistake, the  $\mu$ PD784916A may be deadlocked. This deadlock can be cleared only by reset input.

Table 3-2 lists the special function registers (SFRs). The meanings of the symbols in this table are as follows:

Abbreviation	Abbreviation o	f an SFR.	This abbreviation is reserved for NEC's asse	embler
	(RA78K4). Wit	th a C comp	piler (CC78K4), the abbreviation can be used as	an sfr
	variable by the	#pragma s	sfr instruction.	

• R/W ...... Indicates whether the SFR in question can be read or written.

R/W: Read/writeR: Read onlyW: Write only

• Bit length......Indicates the bit length (word length) of the SFR.

• Bit units for manipulation ...... Indicates bit units in which the SFR in question can be manipulated. An SFR that can be manipulated in 16-bit units can be described as the operand sfrp of an instruction. Specify an even address to manipulate this SFR.

An SFR that can be manipulated in 1-bit units can be described for a bit manipulation instruction.

After reset ...... Indicates the status of each register after the RESET signal has been input.

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Table 3-2. Special Function Registers (1/4)

				Bit	В	it Units f	or	After
Address	Special Function Register (SFR) Name	Special Function Register (SFR) Name   Symbol   R/W   Length		Length	М	anipulati	Releasing	
					1 bit	8 bits	16 bits	Reset
FF00H	Port 0	P0	R/W	8	0	0	-	Undefined
FF04H	Port 4	P4		8	0	0	_	
FF05H	Port 5	P5		8	0	0	_	
FF06H	Port 6	P6		8	0	0	-	
FF07H	Port 7	P7	R	8	0	0	-	
FF08H	Port 8	P8	R/W	8	0	0	-	
FF09H	Port 9	P9		8	0	0	_	
FF0EH	Port 0 buffer register L	P0L		8	0	0	_	
FF0FH	Port 0 buffer register H	P0H		8	0	0	_	
FF10H	Timer 0 compare register 0	CR00		16	-	-	0	Cleared to 0
FF11H	Event counter compare register 0	ECC0	W	8	_	0	_	
FF12H	Timer 0 compare register 1	CR01	R/W	16	-	-	0	
FF13H	Event counter compare register 1	ECC1	W	8	-	0	_	
FF14H	Timer 0 compare register 2	CR02	R/W	16	-	-	0	
FF15H	Event counter compare register 2	ECC2	W	8	-	0	_	
FF16H	Timer 1 compare register 0	CR10	R/W	16	-	-	0	
FF17H	Event counter compare register 3	ECC3	W	8	-	0	_	
FF18H	Timer 1 compare register 1	CR11	R/W	16	-	-	0	
FF1AH	Timer 1 compare register 2	CR12	R	16	-	-	0	
FF1CH	Timer 1 compare register 3	CR13	R/W	16	-	-	0	
FF1EH	Timer 2 compare register 0	CR20		16	-	-	0	
FF20H	Port 0 mode register	PM0	W	8	-	0	_	FFH
FF24H	Port 4 mode register	PM4		8	_	0	_	
FF25H	Port 5 mode register	PM5		8	-	0	_	
FF26H	Port 6 mode register	PM6		8	-	0	-	
FF28H	Port 8 mode register	PM8		8	_	0	-	FDH
FF29H	Port 9 mode register	PM9		8	-	0	-	7FH
FF2EH	Real-time output port 0 control register	RTPC	R/W	8	0	0	-	00H
FF30H	Timer register 0	TM0	R	16	-	-	0	Cleared to 0
FF31H	Event counter	EC	R/W	8	-	0	-	
FF32H	Timer register 1	TM1	R	16	-	-	0	
FF34H	Free running counter (bits 0 to 15)	FRCL		16	-	-	0	0000H
FF35H	Free running counter (bits 16 to 21)	FRCH			_	0	_	00H
FF36H	Timer register 2	TM2		16	_	-	0	Cleared to 0
FF38H	Timer control register 0	TMC0	R/W	8	0	0	_	00H
FF39H	Timer control register 1	TMC1		8	0	0	_	
FF3AH	Timer control register 2	TMC2	1	8	0	0	_	
FF3BH	Timer control register 3	TMC3		8	0	0	_	00×00000

Table 3-2. Special Function Registers (2/4)

			R/W	Bit Length		it Units f		After
Address	Special Function Register (SFR) Name	Symbol				anipulati	1	Releasing
					1 bit	8 bits	16 bits	Reset
FF3CH	Timer register 3	TM3	R	16	_	-	0	Cleared to 0
FF3DH	Timer control register 4	TMC4	R/W	8	0	0	-	××000000
FF3EH	Timer register 4	TM4	R	16	-	-	0	Cleared to 0
FF48H	Port 8 mode control register	PMC8	R/W	8	0	0	-	00H
FF4DH	Trigger source select register	TRGS0		8	0	0	-	
FF4EH	Pull-up resistor option register L	PUOL		8	0	0	-	
FF4FH	Pull-up resistor option register H	PUOH		8	0	0	_	
FF50H	Input control register	ICR		8	0	0	_	10H
FF51H	Up/down counter count register	UDC		8	_	0	_	Undefined
FF52H	Event divider counter	EDV	R	8	-	0	_	Cleared to 0
FF53H	Capture mode register	CPTM	R/W	8	0	0	-	00H
FF54H	Timer register 5	TM5	R	16	-	-	0	Cleared to 0
FF56H	Timer 3 capture register 0	CPT30		16	-	-	0	
FF58H	Timer 0 output mode register	TOM0	W	8	-	0	-	××000000
FF59H	Timer 0 output control register	TOC0		8	-	0	-	00H
FF5AH	Timer 1 output mode register	TOM1 <sup>Note 1</sup>	R/W	8	-	0	-	80H
FF5BH	Timer 1 output control register	TOC1	W	8	-	0	-	00H
FF5CH	Timer 3 compare register 0	CR30	R/W	16	-	-	0	Cleared to 0
FF5EH	Timer 3 compare register 1	CR31		16	-	-	0	
FF60H	Port 8 buffer register L	P8L		8	0	0	-	000×0×0×
FF63H	Up/down counter compare register	UDCC	W	8	-	0	-	Undefined
FF65H	Trigger source select register 1	TRGS1	R/W	8	0	0	-	00H
FF66H	Port 6 mode control register	PMC6		8	0	0	_	
FF68H	A/D converter mode register	ADM		16	-	-	0	0000H
		ADMLNote 2		8	0	0	-	
FF6AH	A/D conversion result register	ADCR	R	8	_	0	-	Undefined
FF6CH	Hardware watch counter 0	HW0	R/W	16	-	-	0	Not affected
FF6EH	Hardware watch counter 1	HW1 R 16 -		-	-	0	by reset	
FF6FH	Watch mode register	WM	R/W	8	0	0	-	00××0×00
FF70H	PWM control register 0	PWMC0	R/W	8	0	0	-	05H
FF71H	PWM control register 1	PWMC1		8	0	0	-	15H
FF72H	PWM0 modulo register	PWM0		16	-	_	0	0000H
FF73H	PWM2 modulo register	PWM2		8	-	0	-	00H
FF74H	PWM1 modulo register	PWM1		16	-	-	0	0000H
FF75H	PWM3 modulo register	PWM3		8	-	0	-	00H

**Notes 1.** When the timer 1 output mode register (TOM1) is read, the write sequence of the REC driver is read (bits 0 and 1).

2. ADML is the lower 8 bits of the A/D converter mode register (ADM) and can be manipulated in 1- or 8-bit units.



Table 3-2. Special Function Registers (3/4)

					Bit	В	it Units f	or	After
Address	Address Special Function Register (SFR) Name		bol	R/W	Length	Manipulation		on	Releasing
						1 bit	8 bits	16 bits	Reset
FF76H	PWM5 modulo register	PW	M5	R/W	16	-	-	0	0000H
FF77H	PWM4 modulo register	PW	M4		8	-	0	-	00H
FF78H	Event divider control register	ED	√C	W	8	-	0	-	00H
FF79H	Clock output mode register	CLC	MC	R/W	8	0	0	-	00H
FF7AH	Timer 4 capture/compare register 0	CR	40		16	-	-	0	Cleared to 0
FF7BH	Clock control register	C	С		8	0	0	-	00H
FF7CH	Timer 4 capture register 1	CR	41	R	16	-	-	0	Cleared to 0
FF7DH	Capture/compare control register	CR	C	W	8	-	0	-	00H
FF7EH	Timer 5 compare register	CR	50	R/W	16	-	-	0	Cleared to 0
FF84H	Serial mode register 1	CSI	M1		8	0	0	-	00H
FF85H	Serial shift register 1	SIC	)1		8	-	0	-	Undefined
FF88H	Serial mode register 2	CSI	M2		8	0	0	-	00H
FF89H	Serial shift register 2	SIC	)2		8	-	0	-	Undefined
FF8AH	Serial control register 2	CSI	C2		8	-	0	-	00H
FF91H	Head amplifier switch output control register	HA	PC		8	0	0	-	
FF94H	Amplifier control register	AM	PC		8	0	0	-	
FF95H	Amplifier mode register 0	AMF	PM0		8	0	0	-	
FF96H	Amplifier mode register 1	AMF	M1		8	0	0	-	
FF97H	Gain control register	СТІ	_M		8	0	0	-	
FFA0H	External interrupt mode register	INT	M0		8	0	0	-	000000×0
FFA1H	External capture mode register 1	INT	M1		8	0	0	_	00H
FFA2H	External capture mode register 2	INT	M2		8	0	0	-	
FFA6H	Key interrupt control register	KE'	YC		8	0	0	-	70H
FFA8H	In-service priority register	ISF	PR	R	8	0	0	-	00H
FFAAH	Interrupt mode control register	IM	С	R/W	8	0	0	-	80H
FFACH	Interrupt mask flag register	MK0L	MK0		8	0	0	0	FFH
FFADH		MK0H	IVIIXO		8	0	0		
FFAEH		MK1L	MK1		8	0	0	0	
FFAFH		MK1H	IVIIXI		8	0	0		
FFB0H	FRC capture register 0L	CPT0L		R	16	-	-	0	Cleared to 0
FFB1H	FRC capture register 0H	CPT0H			8	-	0	-	
FFB2H	FRC capture register 1L	CPT1L			16	-	-	0	
FFB3H	FRC capture register 1H	CPT1H			8	-	0	_	
FFB4H	FRC capture register 2L	CPT2L			16	-	-	0	
FFB5H	FRC capture register 2H	CPT2H			8	_	0	-	
FFB6H	FRC capture register 3L	CP1	3L		16	_	-	0	
FFB7H	FRC capture register 3H	СРТ	3H		8	-	0	-	
FFB8H	FRC capture register 4L	CP1	4L		16	_	-	0	

Table 3-2. Special Function Registers (4/4)

				Bit	В	it Units f	or	After
Address Special Function Register (SFR) Name		Symbol	R/W	Length	М	anipulati	Releasing	
					1 bit 8 bits		16 bits	Reset
FFB9H	FRC capture register 4H	CPT4H	R	8	-	0	-	Cleared to 0
FFBAH	FRC capture register 5L	CPT5L	1	16	_	-	0	
FFBBH	FRC capture register 5H	CPT5H		8	-	0	_	
FFC0H	Standby control register	STBC	R/W	8	-	0	-	0000×000
FFC4H	Execution speed select register	MM	W	8	-	0	_	20H
FFCEH	CPU clock status register	PCS	R	8	0	0	_	00H
FFCFH	Oscillation stabilization time specification register	OSTS	W	8	-	0	_	
FFE0H	Interrupt control register (INTP0)	PIC0	R/W	8	0	0	_	43H
FFE1H	Interrupt control register (INTCPT3)	CPTIC3		8	0	0	-	
FFE2H	Interrupt control register (INTCPT2)	CPTIC2		8	0	0	_	
FFE3H	Interrupt control register (INTCR00)	CRIC12	1	8	0	0	_	
FFE4H	Interrupt control register (INTCR00)	CRIC00	1	8	0	0	_	
FFE5H	Interrupt control register (INTCLR1)	CLRIC1	1	8	0	0	_	
FFE6H	Interrupt control register (INTCR10)	CRIC10		8	0	0	_	
FFE7H	Interrupt control register (INTCR01)	CRIC01	CRIC01 8		0	0	_	
FFE8H	Interrupt control register (INTCR02)	CRIC02		8	0	0	_	
FFE9H	Interrupt control register (INTCR11)	CRIC11	CRIC11 8		0	0	_	
FFEAH	Interrupt control register (INTCPT1)	CPTIC1		8	0	0	_	
FFEBH	Interrupt control register (INTCR20)	CRIC20		8	0	0	-	
FFEDH	Interrupt control register (INTTB)	TBIC	]	8	0	0	_	
FFEEH	Interrupt control register (INTAD)	ADIC		8	0	0	-	
FFEFH	Interrupt control register (INTP2)Note	PIC2		8	0	0	-	
	Interrupt control register (INTCR40)Note	CRIC40						
FFF0H	Interrupt control register (INTUDC)	UDCIC		8	0	0	-	
FFF1H	Interrupt control register (INTCR30)	CRIC30		8	0	0	_	
FFF2H	Interrupt control register (INTCR50)	CRIC50		8	0	0	_	
FFF3H	Interrupt control register (INTCR13)	CRIC13 8		8	0	0	-	
FFF4H	Interrupt control register (INTCSI1)	CSIIC1	CSIIC1 8		0	0	-	
FFF5H	Interrupt control register (INTW)	WIC	8		0	0	-	
FFF7H	Interrupt control register (INTP1)	PIC1		8 (		0	-	
FFF8H	Interrupt control register (INTP3)	PIC3		8	0	0	-	
FFFAH	Interrupt control register (INTCSI2)	CSIIC2		8	0	0	_	

Note PIC2 and CRIC40 are at the same address (register).

# 3.4 PORTS

The  $\mu$ PD784916A is provided with the ports shown in Figure 3-4. Table 3-3 shows the function of each port.

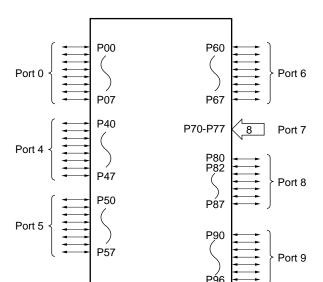


Figure 3-4. Port Configuration

Table 3-3. Port Function

Name	Pin Name	Function	Specification of Pull-up Resistor
Port 0	P00-P07	Can be set in input or output mode in	Pull-up resistors are connected to all
Port 4	P40-P47	1-bit units.	pins in input mode.
Port 5	P50-P57		
Port 6	P60-P67		
Port 7	P70-P77	Input port	Pull-up resistor is not provided.
Port 8	P80, P82-P87	Can be set in input or output mode in	Pull-up resistors are connected to all
Port 9	P90-P96	1-bit units.	pins in input mode.

#### 3.5 Real-time Output Port

A real-time output port consists of a port output latch and a buffer register (refer to Figure 3-5).

The function to transfer the data prepared in advance in the buffer register to the output latch when a trigger such as a timer interrupt occurs, and output the data to an external device is called a real-time output function. A port used in this way is called a real-time output port (RTP).

Table 3-4 shows the real-time output ports of the  $\mu$ PD784916A.

Table 3-5 shows the trigger sources of RTPs.

Figure 3-5. Configuration of RTP

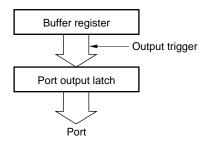


Table 3-4. Bit Configuration of RTP

	Alternate	Number of Bits of	Number of Bits That	
RTP	Function	Real-Time Output	Can Be Specified as	Remark
		Data	RTP	
RTP0	Port 0	4 bits x 2 channels or	4-bit units	-
		8 bits x 1 channel		
RTP8	Port 8	1 bit x 1 channel and	1-bit units	Pseudo Vsync output: 1 channel (RTP80)
		2 bits x 1 channel		Head amplifier switch: 1 channel (RTP82)
				Chrominance rotation signal output: 1
				channel (RTP83)

Table 3-5. Trigger Sources of RTP

	Trigger Source	INTCR00	INTCR01	INTCR02	INTCR13	INTCR50	INTCR0	Remark
RTP								
RTP0	Higher 4 bits		0					
	Lower 4 bits			0			0	
	All 8 bits			0			0	
RTP8	Bit 0		0	0	0	0		Note 1
	Bits 2 and 3	0						Note 2

Notes 1. Select one of the four trigger sources.

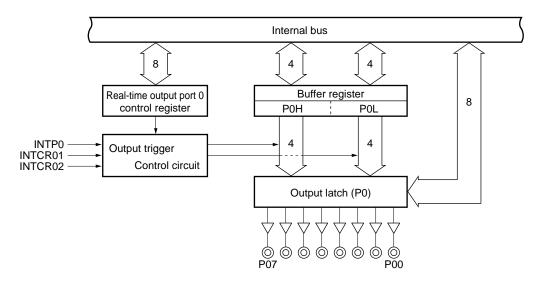
2. When the real-time output port mode is set by the port mode control register 8 (PMC8), the HASW and ROT-C signals that are set by the head amplifier switch output control register (HAPC) are directly output. The HASW and ROT-C signals are synchronized with HSW output (TM0-CR00 coincidence signal). However, the set signal is output immediately when the HAPC register is rewritten.



Figures 3-6 and 3-7 show the block diagrams of RTP0 and RTP8.

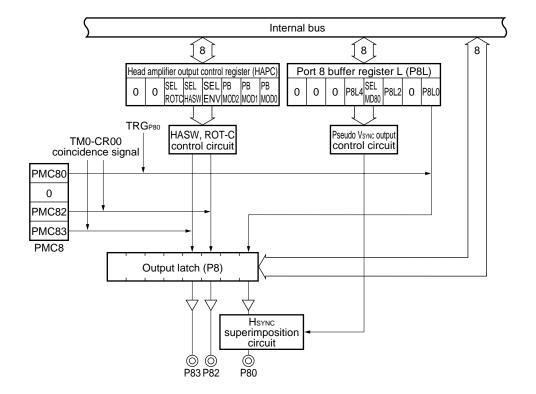
Figure 3-8 shows the types of RTP output trigger sources.

Figure 3-6. Block Diagram of RTP0



Remark INTCR01: TM0-CR01 coincidence signal INTCR02: TM0-CR02 coincidence signal

Figure 3-7. Block Diagram of RPT8



Real-time output port 0 control register (RTPC) INTP0 🔘 TM0 Selector Trigger of P0H Trigger of P0L CR00 Interrupt and timer output CR01 ► Trigger of P82 and P83 CR02 Selector ➤ Trigger of P80 TM1 Trigger source select register 0 (TRGS0) CR10 Interrupt and timer output CR11 Capture CR12 Interrupt CR13 TM5 CR50 ► Interrupt

Figure 3-8. Types of RTP Output Trigger Sources



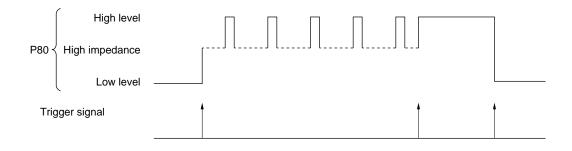
RTP80 can output low-level, high-level, and high-impedance values real-time.

Because RTP80 can superimpose a horizontal sync signal, it can be used to create a pseudo vertical sync signal. When RTP80 is set in the pseudo Vsync output mode, it repeatedly outputs a specific pattern when an output trigger occurs.

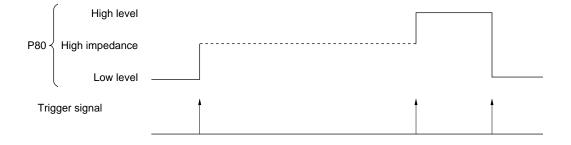
Figure 3-9 shows the operation timing of RTP80.

Figure 3-9. Example of Operation Timing of RTP80

# (a) When Hsync signal is superimposed



# (b) Pseudo Vsync output mode





# 3.6 Super Timer Unit

The  $\mu$ PD784916A is provided with a super timer unit that consists of the timers shown in Table 3-6.

Table 3-6. Configuration of Super Timer Unit

Unit Name	Timer/Counter	Resolution	Maximum Count Time	Register	Remark
Timer 0	TM0	1 μs	65.5 ms	CR00	Controls delay of video head switching signal
	(16-bit timer)			CR01	Controls delay of audio head switching signal
				CR02	Controls pseudo Vsync output timing
	EC	_	_	ECC0, ECC1,	Creates internal head switching signal
	(8-bit counter)			ECC2, ECC3	
Free running	FRC	125 ns	524 ms	CPT0	Detects reference phase (to control drum phase)
counter	(22-bit counter)			CPT1	Detects phase of drum motor (to control drum phase)
				CPT2	Detects speed of drum motor (to control drum speed)
				CPT3	Detects speed of capstan motor (to control speed of capstan motor)
				CPT4, CPT5	Detects remaining tape for reel FG
Timer 1	TM1 (16-bit timer)	1 μs	65.5 ms	CR10	Playback: Creates internal reference signal Recording: Buffer oscillator in case Vsync is missing
				CR11	Controls RECCTL output timing
				CR12	Detects phase of capstan motor (to control capstan phase)
				CR13	Controls V <sub>SYNC</sub> mask as noise prevention measures
	TM3 (16-bit timer)	1 μs or 1.1 μs	65.5 ms or 71.5 ms	CR30, CR31	Controls duty detection timing of PBCTL signal
				CPT30	Measures cycle of PBCTL signal
	EDV (8-bit counter)	_	_	EDVC	Divides CFG signal frequency
Timer 2	TM2 (16-bit timer)	1 μs	65.5 ms	CR20	Can be used as interval timer (to control system)
Timer 4	TM4 (16-bit timer)	2 μs	131 ms	CR40	Detects duty of remote controller signal (to decode remote controller signal)
				CR41	Measures cycle of remote controller signal (to decode remote controller signal)
Timer 5	TM5 (16-bit timer)	2 μs	131 ms	CR50	Can be used as interval timer (to control system)
Up/down	UDC	_	_	UDCC	Creates linear tape counter
counter	(5-bit counter)				, , , , ,
PWM output	-	_	_	PWM0, PWM1,	16-bit resolution (carrier frequency: 62.5 kHz)
unit				PWM5 PWM2, PWM3, PWM4	8-bit resolution (carrier frequency: 62.5 kHz)



#### (1) Timer 0 unit

Timer 0 unit creates head switching signal and pseudo VsyNc output timing from the PG and FG signals of the drum motor.

This unit consists of an event counter (EC: 8 bits), four compare registers (ECC0 through ECC3), a timer (TM0: 16 bits), and three compare registers (CR00 through CR02).

A signal indicating coincidence between the value of timer 0 and the value of a compare register can be used as the output trigger of the real-time output port.

# (2) Free running counter unit

The free running counter unit detects the speed and phase of the drum motor, and the speed and reel speed of the capstan motor.

This unit consists of a free running counter (FRC), six capture registers (CPT0 through CPT5), a VsyNc separation circuit, and a HsyNc separation circuit.

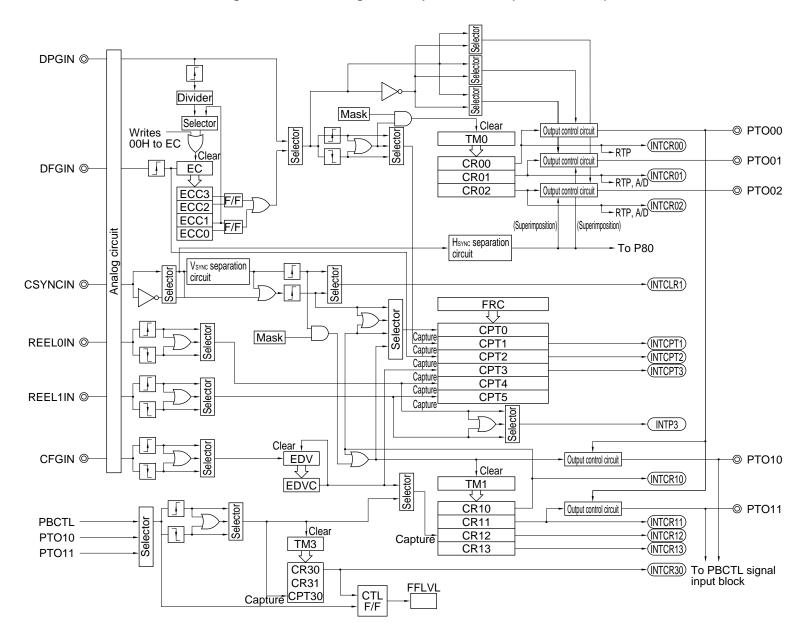
#### (3) Timer 1 unit

Timer 1 unit is a reference timer unit synchronized with the frame cycle and creates the RECCTL signal, detects the phase of the capstan motor, and detects the duty factor of the PBCTL signal. This unit consists of the following three groups:

- Timer 1 (TM1), compare registers (CR10, CR11, and CR13), and capture register (CR12)
- Timer 3 (TM3), compare registers (CR30 and CR31), and capture register (CPT30)
- Event divider counter (EDV) and compare register (EDVC)

The TM1-CR13 coincidence signal can be used for automatic unmasking of V<sub>SYNC</sub> or as the output trigger of the real-time output port.

## ★ Figure 3-10. Block Diagram of Super Timer Unit (TM0, FRC, TM1)





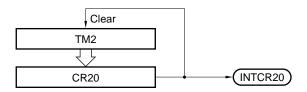
#### (4) Timer 2 unit

Timer 2 unit is a general-purpose 16-bit timer unit.

This unit consists of a timer 2 (TM2) and a compare register (CR20).

The timer is cleared when the TM2-CR20 coincidence signal occurs, and at the same time, an interrupt is generated.

Figure 3-11. Block Diagram of Timer 2 Unit



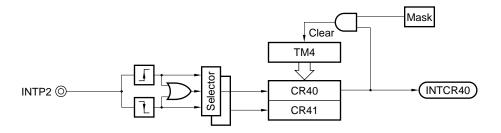
# (5) Timer 4 unit

Timer 4 unit is a general-purpose 16-bit timer unit.

This unit consists of a timer 4 (TM4), a capture/compare register (CR40), and a capture register (CR41).

The value of the timer is captured to CR40/CR41 when the INTP2 signal is input. This timer can be used to decode a remote controller signal.

Figure 3-12. Block Diagram of Timer 4 Unit



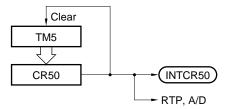
#### (6) Timer 5 unit

Timer 5 unit is a general-purpose 16-bit timer unit.

This unit consists of a timer 5 (TM5) and a compare register (CR50).

The timer is cleared by the TM5-CR50 coincidence signal, and at the same time, an interrupt is generated.

Figure 3-13. Block Diagram of Timer 5 Unit



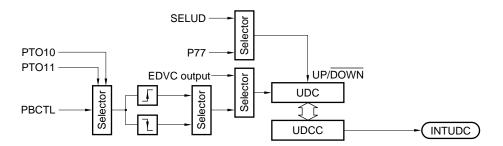
#### (7) Up/down counter unit

The up/down counter unit is a counter that realizes a linear time counter.

This unit consists of an up/down counter (UDC) and a compare register (UDCC).

The up/down counter counts up the rising edges of PBCTL and counts down the falling edges of PBCTL. When the value of the up/down counter coincides with the value of the compare register, or when the counter underflows, an interrupt is generated.

Figure 3-14. Block Diagram of Up/Down Counter Unit



## (8) PWM output unit

The PWM output unit has three 16-bit accuracy output lines (PWM0, PWM1, and PWM5) and 8-bit accuracy output lines (PWM2 through PWM4). The carrier frequency of all the output lines is 62.5 kHz (fclk = 8 MHz). PWM0 and PWM1 can be used to control the drum motor and capstan motor.

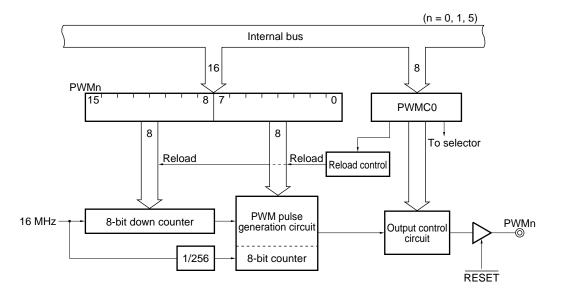


Figure 3-15. Block Diagram of 16-Bit PWM Output Unit



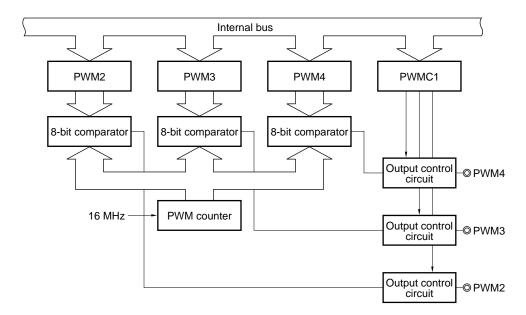


Figure 3-16. Block Diagram of 8-Bit PWM Output Unit

# 3.7 Serial Interface

The  $\mu$ PD784916A is provided with the serial interfaces shown in Table 3-7.

Data can be automatically transmitted or received through these serial interfaces, when the macro service is used.

Table 3-7. Types of Serial Interfaces

Name	Function
Serial interface channel 1	Clocked serial interface (3-wire)
	Bit length: 8 bits
	Clock rate: External clock/31.25 kHz/62.5 kHz/125 kHz/250 kHz/500 kHz/1 MHz
	(fclk = 8 MHz)
	MSB first/LSB first selectable
Serial interface channel 2	Clocked serial interface (3-wire)
	Bit length: 8 bits
	Clock rate: External clock/31.25 kHz/62.5 kHz/125 kHz/250 kHz/500 kHz/1 MHz
	(fclk = 8 MHz)
	MSB first/LSB first selectable
	BUSY/STRB control function

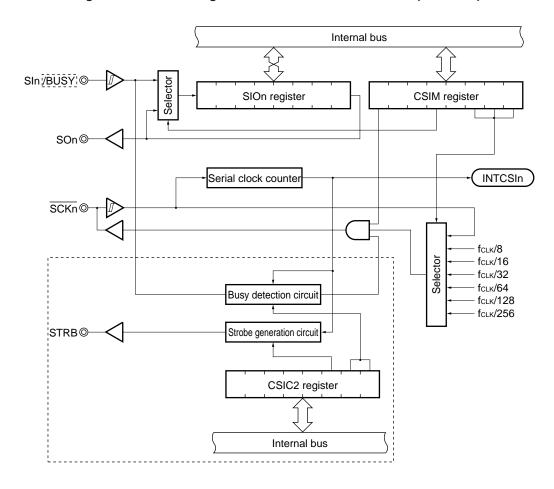


Figure 3-17. Block Diagram of Serial Interface Channel n (n = 1 or 2)

Remark The circuits enclosed in the broken line are provided for serial interface channel 2 only.



#### 3.8 A/D Converter

The  $\mu$ PD784916A has an analog-to-digital (A/D) converter with 12 multiplexed analog inputs (ANI0 through ANI11). This A/D converter is of successive approximation type, and the conversion result is held by an 8-bit A/D conversion result register (ADCR) (conversion time: 10  $\mu$ s at fclk = 8 MHz).

A/D conversion can be started in the following two modes:

- Hardware start: Conversion is started by a hardware trigger Note.
- Software start: Conversion is started by setting the A/D conversion mode register (ADM).

After conversion has been started, the A/D converter operates in the following modes:

- Scan mode: Sequentially selects more than one analog input to obtain data to be converted from all the pins.
- Select mode: Use only one pin for analog input to obtain successive data.

When the conversion result is transferred to ADCR, interrupt request INTAD is generated. By processing this interrupt with the macro service, the conversion result can be successively transferred to memory.

A mode in which starting A/D conversion of the next pin is kept pending until the value of ADCR is read is also available. When this mode is used, reading the conversion result by mistake when timing is shifted because an interrupt is disabled can be prevented.

**Note** A hardware trigger can be one of the following coincidence signals, one of which is selected by the trigger source select register 1 (TRGS1):

- TM0-CR01 coincidence signal
- TM0-CR02 coincidence signal
- TM1-CR13 coincidence signal
- TM5-CR50 coincidence signal

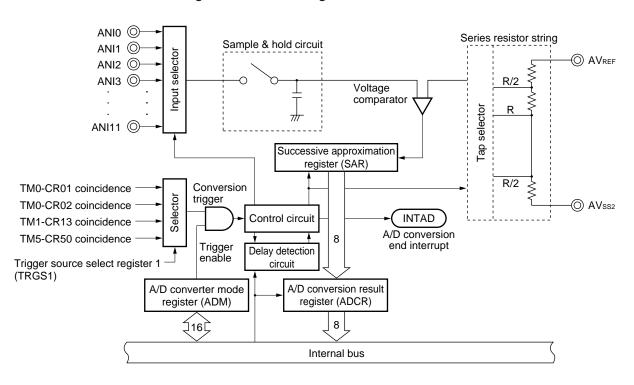


Figure 3-18. Block Diagram of A/D Converter

# 3.9 VCR Analog Circuits

The  $\mu\text{PD784916A}$  is provided with the following VCR analog circuits:

- CTL amplifier
- RECCTL driver (rewritable)
- DPG comparator
- DFG amplifier
- DPFG separation circuit (ternary separation circuit)
- CFG amplifier
- Reel FG comparator (2 channels)
- · CSYNC comparator



#### (1) CTL amplifier/RECCTL driver

The CTL amplifier is used to amplify the playback control (PBCTL) signal that is reproduced from the CTL signal recorded on a VCR tape.

The gain of the CTL amplifier is set by the gain control register (CTLM). Thirty-two types of gains can be set in increments of about 1.78 dB.

The  $\mu$ PD784195 is also provided with a gain control signal generation circuit that monitors the status of the amplifier output to perform optimum gain control by program. The gain control signal generation circuit generates a CTL detection flag that identifies the amplitude status of the CTL amplifier output. By using this CTL detection flag, the gain of the CTL amplifier can be optimized.

The RECCTL driver writes a control signal onto a VCR tape.

This driver operates in two modes: REC mode that is used for recording, and rewrite mode used to rewrite the VISS signal. The output status of the RECCTL± pin is changed by hardware, by using the timer output from the super timer unit as a trigger.

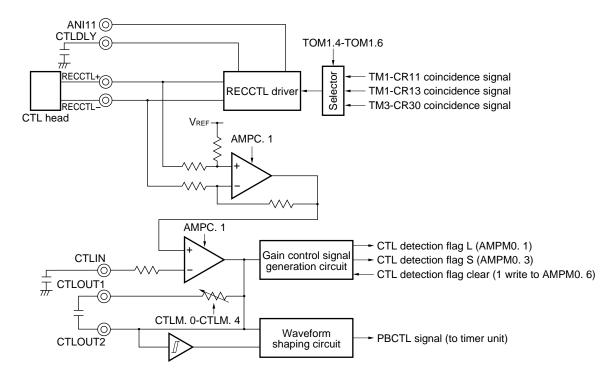


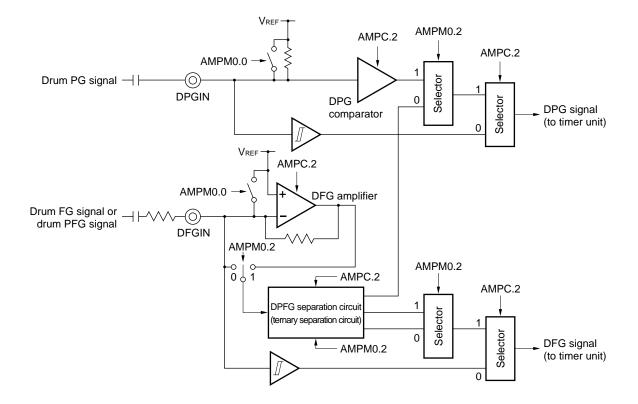
Figure 3-19. Block Diagram of CTL Amplifier and RECCTL Driver

## (2) DPG comparator, DFG amplifier, and DPFG separation circuit

The DPG comparator converts the drum PG (DPG) signal that indicates the phase information of the drum motor into a logic signal.

The DFG amplifier amplifies the drum FG (DFG) signal that indicates the speed information of the drum motor. The DPFG separation circuit (ternary separation circuit) separates a drum PFG (DPFG) signal having speed and phase information into a DFG and DPG signals.

Figure 3-20. Block Diagram of DPG Comparator, DFG Amplifier, and DPFG Separation Circuit





## (3) CFG amplifier

The CFG amplifier amplifies the capstan FG (CFG) signal that indicates the speed information of the capstan motor. This amplifier consists of an operational amplifier and a comparator. The gain of the operational amplifier is set by using an external resistor.

When the gain of the operational amplifier is set to 50 dB, the output duty accuracy of the CFG signal can be improved to  $50.0 \pm 0.3\%$ .

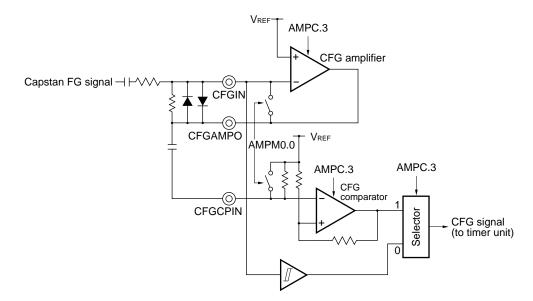
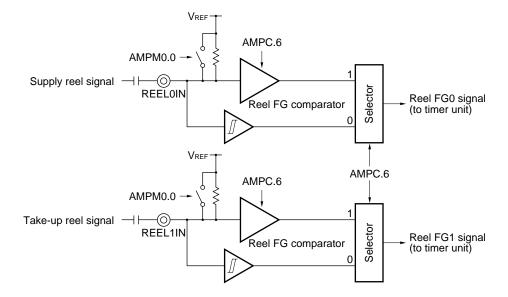


Figure 3-21. Block Diagram of CFG Amplifier

## (4) Reel FG comparators

The reel FG comparator converts a reel FG signal that indicates the speed information of the reel motor into a logic signal. Two comparators, one for take-up and the other for supply, are provided.

Figure 3-22. Block Diagram of Reel FG Comparators



# (5) CSYNC comparator

The CSYNC comparator converts the COMPSYNC signal into a logic signal.

AMPM0.0 AMPC.5

Figure 3-23. Block Diagram of COMPSYNC Comparator



## (6) Reference amplifier

The reference amplifier generates a reference voltage (VREF) to be supplied to the internal amplifiers and comparators of the  $\mu$ PD784916A.

VREFC

VREF (CFG amplifier)

VREF (CFG amplifier)

ENCTL (AMPC.1)

VREF (CTL amplifier)

ENDRUM (AMPC.2)
ENCSYN (AMPC.5)

VREF (DFG amplifier, DPG comparator, reel FG comparator, and CSYNC comparator)

Figure 3-24. Block Diagram of Reference Amplifier

**Remark** Multiple reference amplifiers are provided to assure the accuracy of the amplifiers and comparators.

#### 3.10 Watch Function

The  $\mu$ PD784916A has a watch function that counts the overflow signals of the watch timer by hardware. As the clock, the subsystem clock (32.768 kHz) is used.

Because this watch function is independent of the CPU, it can be used even while the CPU is in the standby mode (STOP mode) or is reset. In addition, this function can be used at a low voltage of  $V_{DD} = 2.7 \text{ V (MIN.)}$ .

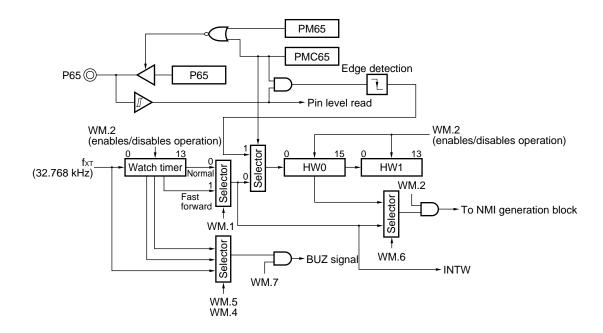
Therefore, by using only the watch function with the CPU set in the standby mode or reset, a watch operation can be performed at a low voltage and low current dissipation.

In addition, the watch function can also be used while the CPU is in the normal operation mode, because a dedicated counter is provided.

The watch function can be used to count up to about 17 years of data.

The hardware watch counters (HW0 and HW1) are shared with external input counters. These counters execute counting at the falling edge of input to the P65 pin, and can be used to count the Hsync signals.

Figure 3-25. Block Diagram of Watch Counter



#### 3.11 Clock Output Function

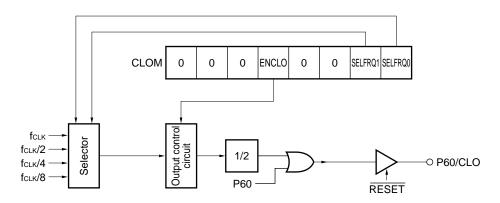
The  $\mu$ PD784916A can output a square wave (with a duty factor of 50%) to the P60/CLO pin as the operating clock for the peripheral devices or other microcomputers. To enable or disable the clock output, and to set the frequency of the clock, the clock output mode register (CLOM) is used.

When setting the frequency, the division ratio can be set to fclk/n (where n = 2, 4, 8, or 16) (fclk = fosc/2: fosc is the oscillation frequency of the oscillator).

Figure 3-26 shows the configuration of the clock output circuit.

The clock output (CLO) pin is shared with P60.

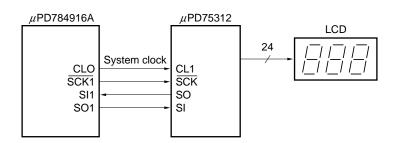
Figure 3-26. Block Diagram of Clock Output Circuit



Remark fclk: internal system clock

Caution Do not use the clock output function in the STOP mode. Clear ENCLO (CLOM.4) to 0 in the STOP mode.

Figure 3-27 Application Example of Clock Output Function





## 4. INTERNAL/EXTERNAL CONTROL FUNCTION

# 4.1 Interrupt Function

The  $\mu$ PD784916A has as many as 30 interrupt sources, including internal and external sources. For 26 sources, a high-speed interrupt processing mode such as context switching or macro service can be specified by software. Table 4-1 lists the interrupt sources.

Table 4-1. Interrupt Sources

Interrupt			Interrupt Request Source	Interrupt	Macro	Context	Macro Service	Vector
Request	Priority	Nesses	T-:	Control Reg-			Control Word	Table
Туре		Name	Trigger	ister Name	Service	Switching	Address	Address
Reset	_	RESET	RESET pin input	_	No	No	_	0000H
Non-	_	NMI	NMI pin input edge	I pin input edge – – – – – – – – – – – – – – – – – – –				0002H
maskable								
Maskable	0	INTP0	INTP0 pin input edge	PIC0	Yes	Yes	FE06H	0006H
	1	INTCPT3	EDVC output signal (CPT3 capture)	CPTIC3			FE08H	0008H
	2	INTCPT2	DFGIN pin input edge (CPT2 capture)	CPTIC2			FE0AH	000AH
	3	INTCR12	PBCTL input edge/EDVC output signal (CR12	CRIC12			FE0CH	000CH
			capture)					
	4	INTCR00	TM0-CR00 coincidence signal	CRIC00			FE0EH	000EH
	5	INTCLR1	CSYNCIN pin input edge	CLRIC1			FE10H	0010H
	6	INTCR10	TM1-CR10 coincidence signal	CRIC10			FE12H	0012H
	7	INTCR01	TM0-CR01 coincidence signal	CRIC01			FE14H	0014H
	8	INTCR02	TM0-CR02 coincidence signal	CRIC02			FE16H	0016H
	9	INTCR11	TM1-CR11 coincidence signal	CRIC11			FE18H	0018H
	10	INTCPT1	Pin input edge/EC output signal (CPT1 cap-	CPTIC1			FE1AH	001AH
			ture)					
	11	INTCR20	TM2-CR20 coincidence signal	CRIC20			FE1CH	001CH
	12	INTTB	Time base from FRC	TBIC			FE20H	0020H
	13	INTAD	A/D converter conversion end	ADIC		FE22H	0022H	
	14	INTP2	INTP2 pin input edge	PIC2			FE24H	0024H
		INTCR40	TM4-CR40 coincidence signal	CRIC40				
	15	INTUDC	UDC-UDCC coincidence/UDC underflow	UDCIC			FE26H	0026H
	16	INTCR30	TM3-CR30 coincidence signal	CRIC30			FE28H	0028H
	17	INTCR50	TM5-CR50 coincidence signal	CRIC50			FE2AH	002AH
	18	INTCR13	TM1-CR13 coincidence signal	CRIC13			FE2CH	002CH
	19	INTCSI1	End of serial transfer (channel 1)	CSIIC1			FE2EH	002EH
	20	INTW	Overflow of watch timer	WIC			FE30H	0030H
	21	INTP1	INTP1 pin input edge	PIC1			FE34H	0034H
	22	INTP3	INTP3 pin input edge	PIC3			FE36H	0036H
	23	INTCSI2	End of serial transfer (channel 2)	CSIIC2			FE3AH	003AH
Operand	-	-	Illegal operand of MOV STBC, #byte or	-	No	No	-	003CH
error			LOCATION instruction					
Software	-	-	Execution of BRK instruction	-			-	003EH
	_	-	Execution of BRKCS instruction	-		Yes	_	-



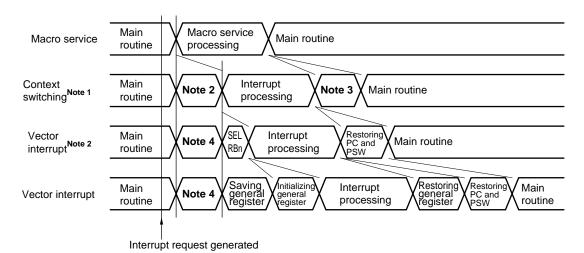


Figure 4-1. Differences in Operation Depending on Interrupt Processing Mode

- **Notes 1.** When the register bank switching function is used and when initial values are set in advance to the registers
  - 2. Selecting a register bank and saving PC and PSW by context switching
  - 3. Restoring register bank, PC, and PSW by context switching
  - 4. Saves PC and PSW to stack and loads vector address to PC

#### 4.1.1 Vector interrupt

When an interrupt is acknowledged, an interrupt processing program is executed according to the data stored in the vector table area (the first address of the interrupt processing program created by the user).

Four levels of priorities can be specified by software for the vector interrupts of the  $\mu$ PD784916A.

## 4.1.2 Context switching

When an interrupt request is generated or when the BRKCS instruction is executed, a specific register bank is selected by hardware, and execution branches to a vector address set in advance in the register bank. At the same time, the current contents of the program counter (PC) and program status word (PSW) are saved to the registers in the register bank. Because the contents of PC and PSW are not saved to the stack area, execution can be branched to an interrupt processing routine more quickly than the vector interrupt.

Register bank <7> 0H (0-7)Register bank n (n = 0-7) PC19-16 PC15-0 Α В <6> Exchange R5 R4 <2> Save R7 R6 Bits 8-11 of temporary <3> Switching register bank <5> Save ٧ VΡ register  $(RSB0-RSB2 \leftarrow n)$ <4> /RSS ← 0 \ U UP Temporary register /IE ←0/ Т D Е <1> Save W Н L **PSW** 

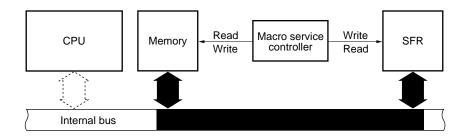
Figure 4-2. Context Switching Operation When Interrupt Request Is Generated

#### 4.1.3 Macro service

The macro service is a function to transfer data between the memory and a special function register (SFR) without intervention by the CPU. A macro service controller accesses the memory and SFR and directly transfers the data.

Because the status of the CPU is not saved or restored, data can be transferred more quickly than context switching. The processing that can be executed with the macro service is described below.

Figure 4-3. Macro Service



#### (1) Counter mode

In this mode, the value of the macro service counter (MSC) is decremented when an interrupt occurs. This mode can be used to execute the division operation of an interrupt or count the number of times an interrupt has occurred.

When the value of the macro service counter has been decremented to 0, a vector interrupt occurs.



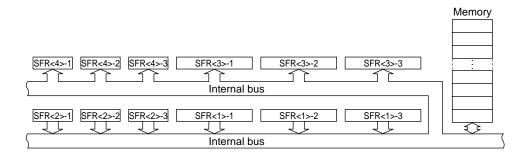
# (2) Compound data transfer mode

When an interrupt occurs, data are simultaneously transferred from an 8-bit SFR to memory, a 16-bit SFR to memory (word), memory (byte) to an 8-bit SFR, and memory (word) to a 16-bit SFR (3 points MAX. for each transfer).

This mode can also be used to exchange data, instead of transferring data.

This mode can be used for automatic transfer/reception by the serial interface or automatic updating of data/timing by the serial output port.

When the value of the macro service counter reaches to 0, a vector interrupt occurs.



#### (3) Macro service type A

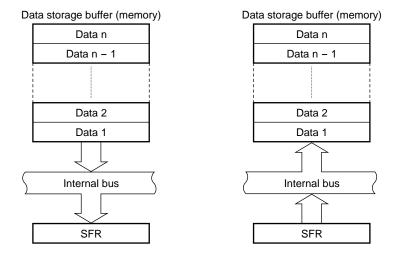
When an interrupt occurs, data is transferred from an 8-/16-bit SFR to memory (byte/word) or from memory (byte/word) to an 8-/16-bit SFR.

Data is transferred the number of times set in advance by the macro service counter.

This mode can be used to store the result of A/D conversion or for automatic transfer (or reception) by the serial interface.

Because transfer data is stored at an address FE00H to FEFFH, if only a small quantity of data is to be transferred, the data can be transferred at high speeds.

When the value of the macro service counter is decremented to 0, a vector interrupt occurs.

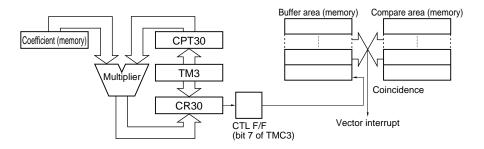


#### (4) Data pattern identification mode (VISS detection mode)

This mode of macro service is for detection of the VISS signal and is used in combination with a pulse width detection circuit.

When an interrupt occurs, the content of bit 7 of an SFR (usually, TMC3) specified by SFR pointer 1 is shifted into the buffer area. At the same time, the data in the buffer area is compared with the data in the compare area. If the two data coincide, an interrupt request is generated. When the value of the macro service counter is decremented to 0, a vector interrupt occurs.

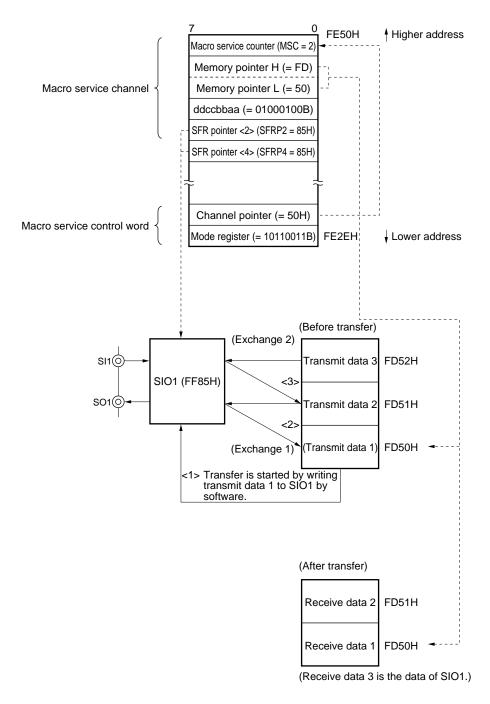
It can be specified by option that the value of an SFR (usually, CPT30) specified by SFR pointer 2 be multiplied by a coefficient and the result of this multiplication be stored to an SFR (usually, CR30) specified by SFR pointer 3 (this operation is to automatically update an identification threshold value when the tape speed fluctuates).



## 4.1.4 Application example of macro service

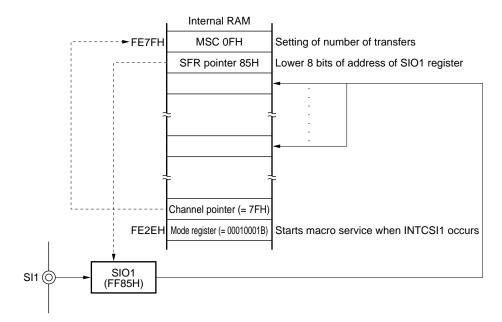
# (1) Automatic transfer/reception of serial interface

Automatic transfer/reception of 3-byte data by serial interface channel 1 Setting of macro service register: compound data transfer mode (exchange mode)



# (2) Reception operation of serial interface

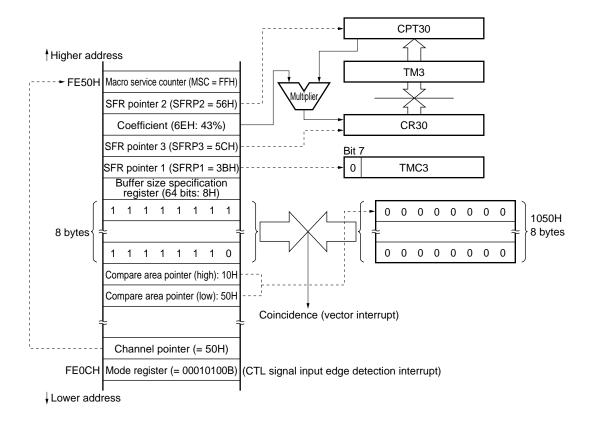
Transfer of receive data by serial interface channel 1 (16 bytes)
Setting of macro service mode register: macro service type A (1-byte transfer from SFR to memory)





## (3) VISS detection operation

Setting of macro service mode register: data pattern identification mode (with multiplication, 8-byte comparison)



## 4.2 Standby Function

The standby function serves to reduce the power dissipation of the chip and is used in the following modes:

Mode	Function
HALT mode	Stops operating clock of CPU. Reduces average power dissipation when
	used in combination with normal mode for intermittent operation
STOP mode	Stops oscillator. Stops all internal operations of chip to minimize current
	dissipation to leakage current only
Low power dissipation mode	Stops main system clock with subsystem clock used as system clock.
	CPU can operate with subsystem clock to reduce power dissipation
Low power dissipation HALT mode	Standby function in low power dissipation mode. Stops operating clock
	of CPU. Reduces power dissipation of overall system

These modes are programmable.

The macro service can be started in the HALT mode.

Macro service request Sets low power dissipation mode Low power End of one processing dissipation mode Normal End of macro service (subsystem clock operation) Restores normal operation operation Interrupt requestinose 2 RESET input Macro Waits for service stabilization of oscillation Low power dissipation HALT mode STOP mode HALT mode (standby) (standby) (standby) Unmasked interrupt request

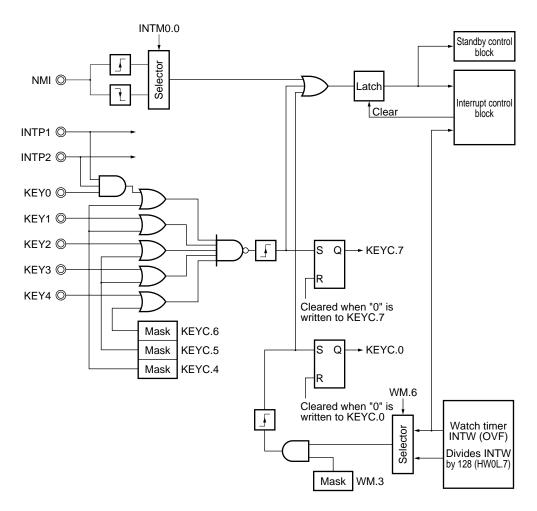
Figure 4-4. Status Transition of Standby Function

Notes 1. NMI input means starting NMI by NMI pin input, watch interrupt, or key interrupt input.

2. Unmasked interrupt request



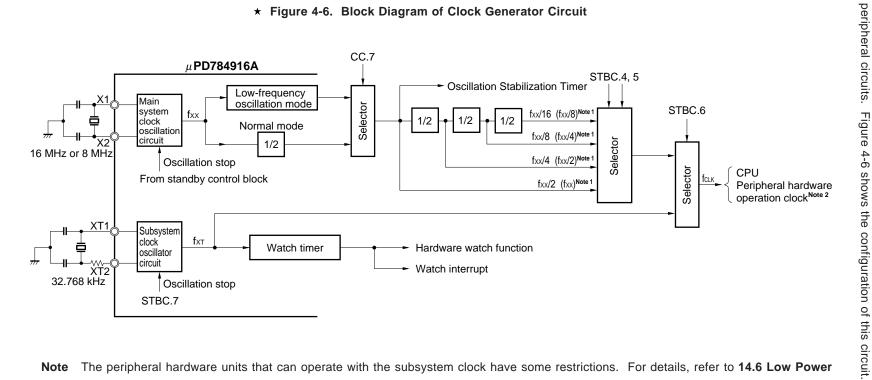
Figure 4-5. Relations among NMI, Watch Interrupt, and Key Interrupt When STOP Mode Is Released



The clock generator circuit generates and controls the internal system clock (CLK) to be supplied to the CPU and

**Clock Generator Circuit** 

# ★ Figure 4-6. Block Diagram of Clock Generator Circuit



Note The peripheral hardware units that can operate with the subsystem clock have some restrictions. For details, refer to 14.6 Low Power Dissipation Mode in  $\mu$ PD784915 Subseries User's Manual.



#### 4.4 Reset Function

When a low-level signal is input to the RESET pin, the system is reset, and each hardware unit is initialized (reset status). During the reset period, oscillation of the system clock is unconditionally stopped, so that the current dissipation of the overall system can be reduced.

When the RESET pin goes high, the reset status is cleared. After the count time of the oscillation stabilization timer (32.8 ms at 16 MHz or 65.6 ms at 8 MHz) has elapsed, the contents of the reset vector table are set to the program counter (PC), and execution branches to the address set to the PC, and the program is executed starting from the branch destination address. Therefore, execution can be reset and started from any address.

Main system clock oscillation circuit

During reset, oscillation is unconditionally stopped.

RESET input

Figure 4-7. Oscillation of Main System Clock during Reset Period

The RESET pin is provided with an analog delay noise rejecter circuit to prevent malfunctioning due to noise.

Oscillation stabilization timer count time

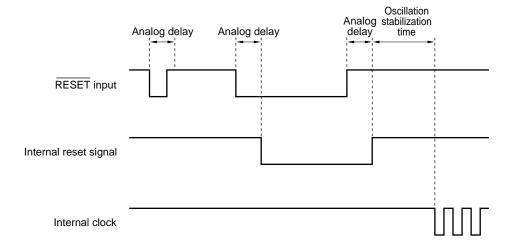


Figure 4-8. Accepting Reset Signal

#### 5. INSTRUCTION SETS

# (1) 8-bit instructions ((): combination realized by describing A as r)

MOV, XCH, ADD, ADDC, SUB, SUBC, AND, OR, XOR, CMP, MULU, DIVUW, INC, DEC, ROR, ROL, RORC, ROLC, SHR, SHL, ROR4, ROL4, DBNZ, PUSH, POP, MOVM, XCHM, CMPME, CMPMNE, CMPMNC, CMPMC, MOVBK, XCHBK, CMPBKNE, CMPBKNE, CMPBKNE, CMPBKNE, CMPBKNE, CHKL, CHKLA

2nd Operand	# byte	А	r	saddr	sfr	!addr16	mem	r3	[WHL+]	[WHL-]	n	None Note 2
	,		r'	saddr'		!!addr24	[saddrp]	PSWL				
1st Operand \							[%saddrg]	PSWH				
A	(MOV)	(MOV)	MOV	(MOV)Note 6	MOV	(MOV)	MOV	MOV	(MOV)	(MOV)		
	ADD <sup>Note 1</sup>	(XCH)	XCH	(XCH)Note 6	(XCH)	(XCH)	XCH		(XCH)	(XCH)		
		(ADD)Note 1	(ADD)Note 1	(ADD)Notes 1,6	(ADD)Note 1	ADDNote 1	ADDNote 1		(ADD)Note 1	(ADD)Note 1		
r	MOV	(MOV)	MOV	MOV	MOV	MOV					ROR <sup>Note 3</sup>	MULU
	ADDNote 1	(XCH)	хсн	XCH	хсн	XCH						DIVUW
		(ADD)Note 1	ADDNote 1	ADDNote 1	ADDNote 1							INC
												DEC
saddr	MOV	(MOV)Note 6	MOV	MOV								INC
	ADD <sup>Note 1</sup>	(ADD)Note 1	ADD <sup>Note 1</sup>	хсн								DEC
				ADDNote 1								DBNZ
sfr	MOV	MOV	MOV									PUSH
	ADDNote 1	(ADD)Note 1	ADDNote 1									POP
												CHKL
												CHKLA
!addr16	MOV	(MOV)	MOV									
!!addr24		ADD <sup>Note 1</sup>										
mem		MOV										
[saddrp]		ADDNote 1										
[%saddrg]												
mem3												ROR4
												ROL4
r3	MOV	MOV										
PSWL												
PSWH												
B, C												DBNZ
STBC, WDM	MOV	(MOV)										
[TDE+]									MOVBKNote 5			
		(ADD)Note 1										
		MOVMNote 4										
[TDE-]		(MOV)								MOVBKNote 5		
		(ADD)Note 1										
		MOVMNote 4										

Notes 1. ADDC, SUB, SUBC, AND, OR, XOR, and CMP are the same as ADD.

- 2. Either the second operand is not used, or the second operation is not an operand address.
- 3. ROL, RORC, ROLC, SHR, and SHL are the same as ROR.
- 4. XCHM, CMPME, CMPMNE, CMPMNC, and CMPMC are the same as MOVM.
- 5. XCHBK, CMPBKE, CMPBKNE, CMPBKNC, and CMPBKC are the same as MOVBK.
- 6. If saddr2 instead of saddr is used in this combination, the code length of some instructions is short.



(2) 16-bit instructions (( ): combination realized by describing AX as rp)

MOVW, XCHW, ADDW, SUBW, CMPW, MULUW, MULW, DIVUX, INCW, DECW, SHRW, SHLW, PUSH, POP, ADDWG, SUBWG, PUSHU, POPU, MOVTBLW, MACW, MACSW, SACW

2nd Operand	# word	AX	rp	saddrp	sfrp	!addr16	mem	[WHL+]	byte	n	None Note 2
			rp'	saddrp'		!!addr24	[saddrp]				
1st Operand \							[%saddrg]				
AX	(MOVM)	(MOVW)	(MOVW)	(MOVW)Note 3	MOVW	(MOVW)	MOVW	(MOVW)			
	ADDW <sup>Note 1</sup>	(XCHW)	(XCHW)	(XCHW)Note 3	(XCHW)	XCHW	XCHW	(XCHW)			
		(ADDW)Note 1	(ADDW)Note 1	(ADDW)Notes 1, 3	(ADDW)Note 1						
rp	MOVW	(MOVW)	MOVW	MOVW	MOVW	MOVW				SHRW	MULWNote 4
	ADDW <sup>Note 1</sup>	(XCHW)	XCHW	XCHW	XCHW					SHLW	INCW
		(ADDW)Note 1	ADDW <sup>Note 1</sup>	ADDW <sup>Note 1</sup>	ADDW <sup>Note 1</sup>						DECW
saddrp	MOVW	(MOVW)Note 3	MOVW	MOVW							INCW
	ADDW <sup>Note 1</sup>	(ADDW)Note 1	ADDWNote 1	XCHW							DECW
				ADDW <sup>Note 1</sup>							
sfrp	MOVW	MOVW	MOVW								PUSH
	ADDWNote 1	(ADDW)Note 1	ADDWNote 1								POP
!addr16	MOVW	(MOVW)	MOVW						MOVTBLW		
!!addr24											
mem		MOVW									
[saddrp]											
[%saddrg]											
PSW											PUSH
											POP
SP	ADDWG										
	SUBWG										
post											PUSH
											POP
											PUSHU
											POPU
[TDE+]		(MOVW)						SACW			
byte											MACW
											MACSW

Notes 1. SUBW and CMPW are the same as ADDW.

- 2. Either the second operand is not used, or the second operation is not an operand address.
- 3. If saddr2 instead of saddr is used in this combination, the code length of some instructions is short.
- 4. MULUW and DIVUX are the same as MULW.

# (3) 24-bit instructions (( ): combination realized by describing WHL as rg) MOVG, ADDG, SUBG, INCG, DECG, PUSH, POP

2nd Operand	# imm24	WHL	rg	saddrg	!!addr24	mem1	[%saddrg]	SP	None <sup>Note</sup>
			rg'						
1st Operand									
WHL	(MOVG)	(MOVG)	(MOVG)	(MOVG)	(MOVG)	MOVG	MOVG	MOVG	
	(ADDG)	(ADDG)	(ADDG)	ADDG					
	(SUBG)	(SUBG)	(SUBG)	SUBG					
rg	MOVG	(MOVG)	MOVG	MOVG	MOVG				INCG
	ADDG	(ADDG)	ADDG						DECG
	SUBG	(SUBG)	SUBG						PUSH
									POP
saddrg		(MOVG)	MOVG						
!!addr24		(MOVG)	MOVG						
mem1		MOVG							
[%saddrg]		MOVG							
SP	MOVG	MOVG							INCG
									DECG

Note Either the second operand is not used, or the second operation is not an operand address.

# (4) Bit manipulation instructions

MOV1, AND1, OR1, XOR1, SET1, CLR1, NOT1, BT, BF, BTCLR, BFSET

2nd Operand	CY	saddr.bit	/saddr.bit	None <sup>Note</sup>
		sfr.bit	/sfr.bit	
		A.bit	/A.bit	
		X.bit	/X.bit	
		PSWL.bit	/PSWL.bit	
		PSWH.bit	/PSWH.bit	
		mem2.bit	/mem2.bit	
		iaddr16.bit	/!addr16.bit	
1st Operand		!addr24.bit	/!!addr24.bit	
CY		MOV1	AND1	NOT1
		AND1	OR1	SET1
		OR1		CLR1
		XOR1		
saddr.bit	MOV1			NOT1
sfr.bit				SET1
A.bit				CLR1
X.bit				BF
PSWL.bit				ВТ
PSWH.bit				BTCLR
mem2.bit				BFSET
!addr16.bit				
!!addr24.bit				

Note Either the second operand is not used, or the second operation is not an operand address.



## (5) Call/return and branch instructions

CALL, CALLF, CALLT, BRK, RET, RETI, RETB, RETCS, RETCSB, BRKCS, BR, BNZ, BNE, BZ, BE, BNC, BNL, BC, BL, BNV, BPO, BV, BPE, BP, BN, BLT, BGE, BLE, BGT, BNH, BH, BF, BT, BTCLR, BFSET, DBNZ

Operand of	\$addr20	\$!addr20	!addr16	!!addr20	rp	rg	[rp]	[rg]	!addr11	[addr5]	RBn	None
instruction												
address												
Basic	BCNote	CALL	CALL	CALL	CALL	CALL	CALL	CALL	CALLF	CALLT	BRKCS	BRK
instruction	BR	BR	BR	BR	BR	BR	BR	BR				RET
			RETCS									RETI
			RETCSB									RETB
Compound	BF											
instruction	ВТ											
	BTCLR											
	BFSET											
	DBNZ											

**Note** BNZ, BNE, BZ, BE, BNC, BNL, BL, BNV, BPO, BV, BPE, BP, BN, BLT, BGE, BLE, BGT, BNH, and BH are the same as BC.

# (6) Other instructions

ADJBA, ADJBS, CVTBW, LOCATION, SEL, NOT, EI, DI, SWRS



## 6. ELECTRICAL CHARACTERISTICS

# Absolute Maximum Ratings ( $T_A = 25^{\circ}C$ )

Parameter	Symbol	Condition	Ratings	Unit
Supply voltage	VDD	VDD - AVDD1   ≤ 0.5 V	-0.5 to +7.0	V
	AV <sub>DD1</sub>	VDD – AVDD2   ≤ 0.5 V	-0.5 to +7.0	V
	AV <sub>DD2</sub>	AVDD1 - AVDD2   ≤ 0.5 V	-0.5 to +7.0	V
	AVss1		-0.5 to +0.5	V
	AVss2		-0.5 to +0.5	V
Input voltage	Vı		-0.5 to V <sub>DD</sub> + 0.5	V
Analog input voltage	VIAN	$V_{DD} \ge AV_{DD2}$	-0.5 to AV <sub>DD2</sub> + 0.5	V
(ANI0-ANI11)		VDD < AVDD2	-0.5 to V <sub>DD</sub> + 0.5	V
Output voltage	Vo		-0.5 to V <sub>DD</sub> + 0.5	V
Low-level output current	lol	Pin 1	15	mA
		Total of all pins	100	mA
High-level output current	Іон	Pin 1	-10	mA
		Total of all pins	-50	mA
Operating ambient temperature	TA		-10 to +70	°C
Storage temperature	Tstg		-65 to +150	°C

Caution If the rated value of even one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings therefore specify the values exceeding which the product may be physically damaged. Never exceed these values when using the product.

# **Operating Conditions**

Clock Frequency	Operating Temperature (TA)	Operating Conditions	Supply Voltage (VDD)
4 MHz ≤ fxx ≤ 16 MHz	−10 to +70°C	All functions	+4.5 to +5.5 V
		CPU function only	+4.0 to +5.5 V
32 kHz ≤ fxτ ≤ 35 kHz		Subclock operation	+2.7 to +5.5 V
		(CPU, watch, and port	
		functions only)	



Oscillator Characteristics (main clock) (TA = -10 to +70°C, VDD = AVDD = 4.0 to 5.5 V, Vss = AVss = 0 V)

Oscillator	Recommended Circuit	Parameter	MIN.	MAX.	Unit
Crystal oscillator	X1 X2 V <sub>SS</sub> ——————————————————————————————————	Oscillation frequency (fxx)	4	16	MHz

Oscillator Characteristics (subclock) (TA = -10 to +70°C, VDD = AVDD = 2.7 to 5.5 V, Vss = AVss = 0 V)

Oscillator	Recommended Circuit	Parameter	MIN.	MAX.	Unit
Crystal oscillator		Oscillation frequency (fxT)	32	35	kHz
	X1 X2 Vss C1 C2				

Caution When using the main system clock and subsystem clock oscillation circuits, wire the portion enclosed by the broken line in the above figures as follows to avoid the adverse influence of wiring capacitance:

- Keep the wiring length as short as possible.
- Do not cross the wiring with the other signal lines. Do not route the wiring in the neighborhood of a signal line through which a high alternating current flows.
- Always keep the ground point of the capacitor of the oscillator circuit to the same potential as Vss. Do not ground the capacitor to a ground pattern to which a high current flows.
- Do not extract signals from the oscillation circuit.

Exercise particular care in using the subsystem clock oscillation circuit because the amplification factor of this circuit is kept low to reduce the power dissipation.



## DC Characteristics (TA = -10 to +70°C, VDD = AVDD = 4.5 to 5.5 V, Vss = AVss = 0 V)

TYP. MAX. Unit Parameter Symbol Conditions MIN. Low-level input voltage V<sub>IL1</sub> Pins other than those listed in Notes 1 and 4 below 0 0.3 VDD ٧  $V_{1L2}$ Pins listed in Notes 1 and 4 below 0 0.2 VDD V X1, X2 0 0.4 ٧ V<sub>IL3</sub> ٧ High-level input voltage  $V_{IH1}$ Pins other than those listed in Note 1 below 0.7 VDD  $V_{DD}$ Pins listed in Note 1 below  $V_{DD}$ ٧  $V_{IH2}$  $0.8 \ V_{DD}$  $V_{\text{IH3}}$ X1, X2  $V_{DD} - 0.5$  $V_{\text{DD}}$ ٧ Low-level output voltage V<sub>OL1</sub> IoL = 5.0 mA (pins in Note 2) 0.6 V V<sub>OL2</sub>  $I_{OL} = 2.0 \text{ mA}$ 0.45 ٧ Vol3  $IoL = 100 \mu A$ 0.25 V High-level output voltage Iон =  $-1.0 \, mA$  $V_{DD} - 1.0$ ٧ V<sub>OH1</sub> Iон =  $-100 \mu A$ V<sub>DD</sub> - 0.4 V  $V_{\text{OH2}}$  $0 \leq V_I \leq V_{DD}$ Input leakage current L ±10 μΑ Output leakage current  $0 \le V_0 \le V_{DD}$ ±10 μΑ ILO fxx = 16 MHz30 V<sub>DD</sub> supply current I<sub>DD1</sub> Operation 50 mΑ mode fxx = 8 MHz (low-frequency oscillation mode) Internally, 8-MHz main system clock operation  $f_{XT} = 32.768 \text{ kHz}$ 50 80 μΑ Subclock operation (CPU, watch, port)  $V_{DD} = 2.7 V$ I<sub>DD2</sub> HALT mode fxx = 16 MHz 10 25 mΑ fxx = 8 MHz (low-frequency oscillation mode) Internally, 8-MHz main clock operation  $f_{XT} = 32.768 \text{ MHz}$ 25 50 μΑ Subclock operation (CPU, watch, port)  $V_{DD} = 2.7 V$ Data hold voltage VDDDR STOP mode 2.5 V Data hold current Note 3 STOP mode Subclock oscillates IDDDR 18 50 μΑ  $V_{DDDR} = 5.0 V$ STOP mode Subclock oscillates 2.5 10 μΑ  $V_{DDDR} = 2.7 V$ Subclock stops STOP mode 0.2 7.0 μΑ  $V_{DDDR} = 2.5 V$  $V_1 = 0 V$ Pull-up resistor  $R_L$ 25 55 110 kΩ

Notes 1. RESET, IC, NMI, INTP0-INTP2, P61/SCK1/BUZ, P63/SI1, SCK2, SI2/BUSY, P65/HWIN, P91/KEY0-P95/KEY4

- 2. P46, P47
- **3.** In the STOP mode in which the subclock oscillation is stopped, disconnect the feedback resistor, and connect the XT1 pin to V<sub>DD</sub>.
- **4.** P40 to P47, P50 to P57

\*



#### **AC Characteristics**

# CPU and peripheral circuit operation clock ( $T_A = -10 \text{ to } +70^{\circ}\text{C}$ , $V_{DD} = AV_{DD} = 4.5 \text{ to } 5.5 \text{ V}$ , $V_{SS} = AV_{SS} = 0 \text{ V}$ )

Parameter	Symbol		Condition	TYP.	Unit
CPU operation clock cycle time	tclk	$f_{XX} = 16 \text{ MHz}$ $V_{DD} = AV_{DD} = 4.0 \text{ to } 5.5 \text{ V}$		125	ns
			CPU Function only		
		fxx = 16 MHz	x = 16 MHz		
		fxx = 8 MHz	low-frequency oscillation mode		
			(Bit 7 of CC = 1)		
Peripheral operation clock cycle time	tclk1	fxx = 16 MHz		125	ns
		fxx = 8MHz	low-frequency oscillation mode		
			(Bit 7 of CC = 1)		

## Serial interface

# (1) SIOn: n = 1 or 2 ( $T_A = -10$ to $+70^{\circ}$ C, $V_{DD} = AV_{DD} = 4.5$ to 5.5 V, $V_{SS} = AV_{SS} = 0$ V)

Parameter	Symbol		Condition	MIN.	MAX.	Unit
Serial clock cycle time	tcysk	Input	External clock	1.0		μs
		Output	fcцк1/8	1.0		μs
			fclк1/16	2.0		μs
			fclк1/32	4.0		μs
			fclк1/64	8.0		μs
			fclк1/128	16		μs
			fclк1/256	32		μs
Serial clock high- and low-level widths	twskh	Input	External clock	420		ns
	twskL	Output	Internal clock	tcysk/2 - 50		ns
SIn setup time (vs. SCKn ↑)	tsssk			100		ns
SIn hold time (vs. SCKn ↑)	thssk			400		ns
SOn output delay time (vs. SCKn ↓)	tossk			0	300	ns

Remarks 1. fclk1: operating clock of peripheral circuit (8 MHz)

**2.** n = 1 or 2

# (2) SIO2 only (TA = $-10 \text{ to } +70^{\circ}\text{C}$ , VDD = AVDD = 4.5 to 5.5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	MAX.	Unit
SCK2(8) ↑→STBR ↑	tdstrb		twskh	tcysk	
Strobe high-level width	twstrb		tсүзк <b>–</b> 30	tсүзк <b>+</b> 30	ns
BUSY setup time	tsbusy		100		ns
(vs. BUSY detection timing)					
BUSY hold time	thbusy		100		ns
(vs. BUSY detection timing)					
BUSY inactive → SCK2(1) ↓	tlbusy			tcysk + twskh	

**Remarks 1.** The value in ( ) following  $\overline{SCK2}$  indicates the number of  $\overline{SCK2}$ .

- 2. BUSY is detected after the time (n+2) x tcγsκ (n = 0, 1, and so on) has elapsed relative to SCK2 (8) ↑.
- 3. BUSY inactive  $\rightarrow \overline{SCK2}$  (1)  $\downarrow$  is the value when data write to SIO2 has been completed.



# Other operations (TA = -10 to +70°C, VDD = AVDD = 4.5 to 5.5 V, Vss = AVss = 0 V)

F	Parameter	Symbol	С	ondition	MIN.	MAX.	Unit
Timer input sign	al low-level width	twcTL	When DFGIN, CFC	SIN, DPGIN, REELOIN,	tclk1		ns
			or REEL1IN logic I				
Timer input sign	al high-level width	twcтн	When DFGIN, CFC	SIN, DPGIN, REELOIN,	tclk1		ns
			or REEL1IN logic I	evel is input			
Timer input sign	al valid edge input cycle	tperin		GIN, or DPGIN is input	2		μs
CSYNCIN low-le		twcr1L	When digital noise el	limination circuit is not used	8tclk1		ns
			When digital noise	elimination circuit is used	108tclk1		ns
			(Bit 4 of INTM2 = 0	0)			
			When digital noise	elimination circuit is used	180tclk1		ns
			(Bit 4 of INTM2 = 1	1)			
CSYNCIN high-	level width	twcr1H	When digital noise el	limination circuit is not used	8tclk1		ns
			When digital noise	elimination circuit is used	108tclk1		ns
			(Bit 4 of INTM2 = 0				
			When digital noise	elimination circuit is used	180tclk1		ns
			(Bit 4 of INTM2 = 1	1)			
Digital noise	Eliminated pulse width	twsep	Bit 4 of INTM2 = 0			104tclk1	ns
elimination			Bit 4 of INTM2 = 1			176tclk1	ns
circuit	Passed pulse width	]	Bit 4 of INTM2 = 0		108tclk1		ns
			Bit 4 of INTM2 = 1		180tcLK1		ns
NMI low-level w	idth	twnil	V <sub>DD</sub> = AV <sub>DD</sub> = 2.7 to	o 5.5 V	10		μs
NMI high-level v	vidth	twnih	$V_{DD} = AV_{DD} = 2.7 \text{ to}$	o 5.5 V	10		μs
INTP0, INTP3 lo	ow-level widths	twiplo			2tclk1		ns
INTP0, INTP3 h	igh-level widths	twipho			2tclk1		ns
INTP1, KEY0-K	EY4 low-level widths	twipL1	Mode other than S	TOP mode	2tclk1		ns
			In STOP mode, for	releasing STOP mode	10		μs
INTP1, KEY0-K	EY4 high-level widths	twiph1	Mode other than S	TOP mode	2tclk1		ns
			In STOP mode, for	releasing STOP mode	10		μs
INTP2 low-level	width	twipl2	In normal mode,	Sampling = fclk	2tclk1		ns
			with main clock	Sampling = fclk/128	32Note		μs
			Normal mode,	Sampling = fclk	61		μs
			with subclock	Sampling = fclk/128	7.9 <sup>Note</sup>		ms
			In STOP mode, for	releasing STOP mode	10		μs
INTP2 high-level width		twiPH2	In normal mode,	Sampling = fclk	2tclk1		ns
			with main clock	Sampling = fclk/128	32Note		μs
			Normal mode,	Sampling = fclk	61		μs
			with subclock	Sampling = fclk/128	7.9 <sup>Note</sup>		ms
			In STOP mode, for	releasing STOP mode	10		μs
RESET low-leve	el width	twrsl			10		μs

**Note** If a high or low level is successively input two times during the sampling period, a high or low level is detected.

Remark tckl1: operating clock cycle time of peripheral circuit (125 ns)



# Clock output operation (TA = -10 to $+70^{\circ}$ C, VDD = AVDD = 4.5 to 5.5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	MAX.	Unit
CLO cycle time	tcycl		250	2000	ns
CLO low-level width	tcll	tcycL/2 ± 50	75	1050	ns
CLO high-level width	tclh	tcycL/2 ± 50	75	1050	ns
CLO rise time	tclr			50	ns
CLO fall time	tclf			50	ns

# Data hold characteristics (TA = -10 to $+70^{\circ}$ C, VDD = AVDD = 2.5 to 5.5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Low-level input voltage	VIL	Special pins (pins in Note)	0		0.1 VDDDR	V
High-level input voltage	VIH		0.9 VDDDR		V <sub>DDDR</sub>	V

Note RESET, IC, NMI, INTP0-INTP2, P61/SCK1/BUZ, P63/SI1, SCK2, SI2/BUSY, P65/HWIN P91/KEY0-P95/KEY4

# Watch function (T<sub>A</sub> = -10 to +70°C, V<sub>DD</sub> = AV<sub>DD</sub> = 2.7 to 5.5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	MAX.	Unit
Subclock oscillation hold voltage	VDDXT		2.7		V
Hardware watch function operating voltage	V <sub>DDW</sub>		2.7		V

# Subclock oscillation stop detection flag ( $T_A = -10 \text{ to } + 70^{\circ}\text{C}$ , $V_{DD} = AV_{DD} = 4.5 \text{ to } 5.5 \text{ V}$ , $V_{SS} = AV_{SS} = 0 \text{ V}$ )

Parameter	Symbol	Condition	MIN.	MAX.	Unit
Oscillation stop detection width	toscf		45		μs

# A/D converter characteristics ( $T_A = -10 \text{ to } +70^{\circ}\text{C}$ , $V_{DD} = AV_{DD} = AV_{REF} = 4.5 \text{ to } 5.5 \text{ V}$ , $V_{SS} = AV_{SS} = 0 \text{ V}$ )

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Resolution			8			bit
Total error		AVREF = VDD			2.0	%
Quantization error					±1/2	LSB
Conversion time	tconv	Bit 4 of ADM = 0	160tcLK1			μs
		Bit 4 of ADM = 1	80tclK1			μs
Sampling time	tsamp	Bit 4 of ADM = 0	32tclK1			μs
		Bit 4 of ADM = 1	16tcLK1			μs
Analog input voltage	VIAN		0		AVREF	V
Analog input impedance	Zan			1000		ΜΩ
AVREF current	Alref			0.4	1.2	mA

# VREF amplifier (TA = 25°C, VDD = AVDD = 5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Reference voltage	VREF		2.35	2.50	2.65	V
Charge current	Існв	Sets AMPM0.0 to 1	300			μΑ
		(pins in Note)				

Note RECCTL+, RECCTL-, CFGIN, CFGCPIN, DFGIN, DPGIN, CSYNCIN, REEL0IN, REEL1IN



# CTL amplifier (TA = 25°C, VDD = AVDD = 5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
CTL+, - input resistance	RICTL		2	5	10	kΩ
Feedback resistance	RFCTL		20	50	100	kΩ
Bias resistance	RBCTL		20	50	100	kΩ
Minimum voltage gain	GCTLMIN		17	20	22	dB
Maximum voltage gain	GCTLMAX		71	75		dB
Gain selecting step	SGAIN			1.77		dB
In-phase elimination ratio	CMR	DC, voltage gain: 20 dB		30		dB
High comparator set voltage of waveform shaping	VPBCTLHS		VREF + 0.47	VREF + 0.50	V <sub>REF</sub> + 0.53	V
High comparator reset voltage of waveform shaping	VPBCTLHR		VREF + 0.27	VREF + 0.30	V <sub>REF</sub> + 0.33	V
Low comparator set voltage of waveform shaping	VPBCTLLS		VREF - 0.53	VREF - 0.50	V <sub>REF</sub> - 0.47	V
Low comparator reset voltage of waveform shaping	VPBCTLLR		VREF - 0.33	VREF - 0.30	V <sub>REF</sub> - 0.27	V
Waveform shaping comparator Schmit width	V <sub>PBSH</sub>		150	200	250	mV
High comparator voltage of CTL flag S	V <sub>FSH</sub>		VREF + 1.00	VREF + 1.05	VREF + 1.10	V
Low comparator voltage of CLT flag S	VFSL		VREF - 1.10	Vref - 1.05	VREF - 1.00	V
High comparator voltage of CTL flag L	V <sub>FLH</sub>		V <sub>REF</sub> + 1.40	V <sub>REF</sub> + 1.45	V <sub>REF</sub> + 1.50	V
Low comparator voltage of CTL flag L	VFLL		VREF - 1.50	VREF - 1.45	V <sub>REF</sub> - 1.40	V

# CFG amplifier (AC coupling) ( $TA = 25^{\circ}C$ , VDD = AVDD = 5 V, Vss = AVss = 0 V)

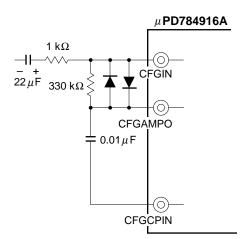
Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Voltage gain 1	G <sub>CFG1</sub>	fi = 2 kHz, open loop	50			dB
Voltage gain 2	G <sub>CFG2</sub>	fi = 30 kHz, open loop	34			dB
CFGAMPO High-level output current	Іонсга	DC	-1			mA
CFGAMPO Low-level output current	lolcfg	DC	0.1			mA
High comparator voltage	Vcfgh		VREF + 0.09	V <sub>REF</sub> + 0.12	VREF + 0.15	V
Low comparator voltage	Vcfgl		Vref - 0.15	Vref - 0.12	Vref - 0.09	V
Duty accuracy	Роиту	Note	49.7	50.0	50.3	%

Note The conditions include the following circuit and input signal.

Input signal : Sine wave input (5  $mV_{p-p}$ )

 $f_i = 1 \text{ kHz}$ 

Voltage gain: 50 dB



.



# DFG amplifier (AC coupling) (TA = 25°C, VDD = AVDD = 5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Voltage gain	GDFG	fi = 900 Hz, open loop	50			dB
Feedback resistance	RFDFG		160	400	640	kΩ
Input protection resistance	Ridfg			150		Ω
High comparator voltage	VDFGH		VREF + 0.07	VREF + 0.10	VREF + 0.14	V
Low comparator voltage	VDFGL		VREF - 0.14	Vref - 0.10	VREF - 0.07	V

Caution Set the input resistance connected to the DFGIN pin to 16  $k\Omega$  or below. Connecting a resistor exceeding that value may cause the DFG amp to oscillate.

# DPG comparator (AC coupling) (TA = 25°C, VDD = AVDD = 5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input impedance	ZIDPG		20	50	100	kΩ
High comparator voltage	VDPGH		VREF + 0.02	VREF + 0.05	VREF + 0.08	V
Low comparator voltage	VDPGL		V <sub>REF</sub> - 0.08	V <sub>REF</sub> - 0.05	VREF - 0.02	V

# Ternary separation circuit (TA = 25°C, VDD = AVDD = 5 V, Vss = AVss = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input impedance	ZIPFG		20	50	100	kΩ
High comparator voltage	Vpfgh		VREF + 0.5	Vref + 0.7	Vref + 0.9	V
Low comparator voltage	Vpfgl		V <sub>REF</sub> – 1.4	Vref - 1.2	VREF - 1.0	V

# CSYNC comparator (AC coupling) ( $T_A = 25^{\circ}C$ , $V_{DD} = AV_{DD} = 5 \text{ V}$ , $V_{SS} = AV_{SS} = 0 \text{ V}$ )

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input impedance	Zicsyn		20	50	100	kΩ
High comparator voltage	Vcsynh		VREF + 0.07	VREF + 0.10	VREF + 0.13	V
Low comparator voltage	Vcsynl		VREF - 0.13	Vref - 0.10	Vref - 0.07	V

# Reel FG comparator (AC coupling) ( $T_A = 25^{\circ}C$ , $V_{DD} = AV_{DD} = 5 V$ , $V_{SS} = AV_{SS} = 0 V$ )

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input impedance	Zirlfg		20	50	100	kΩ
High comparator voltage	VRLFGH		V <sub>REF</sub> + 0.02	VREF + 0.05	VREF + 0.08	V
Low comparator voltage	VRLFGL		Vref – 0.08	Vref - 0.05	Vref - 0.02	V

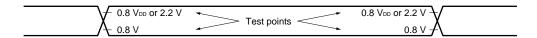
# RECCTL driver (T<sub>A</sub> = $25^{\circ}$ C, V<sub>DD</sub> = AV<sub>DD</sub> = 5 V, V<sub>SS</sub> = AV<sub>SS</sub> = 0 V)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
RECCTL+, - high-level output voltage	Vohrec	Iон = −4 mA	VDD - 0.8			V
RECCTL+, - low-level output voltage	Volrec	IoL = 4 mA			0.8	V
CTLDLY internal resistance	Rctl		40	70	140	kΩ
CTLDLY charge current	Іонсть	Use of internal resistor	-3			mA
CTLDLY discharge current	Іостть		-3			mA

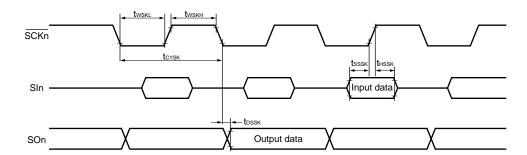


# Timing waveform

AC timing test point



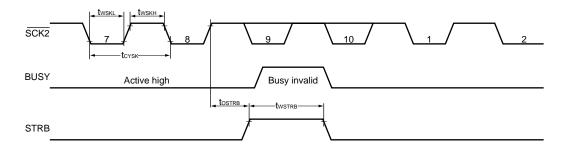
Serial transfer timing (SIOn: n = 1 or 2)



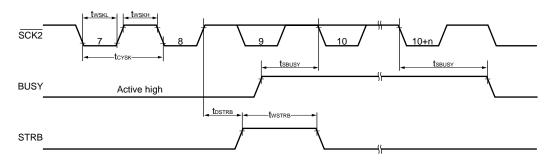


### Serial transfer timing (SIO2 only)

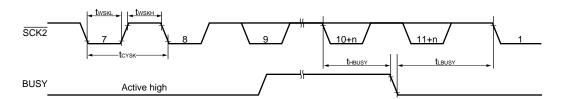
No busy processing



Continuation of busy processing



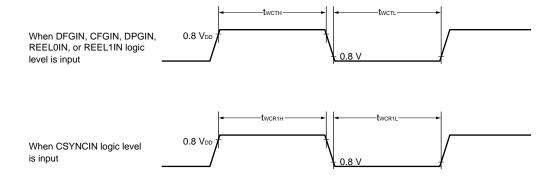
End of busy processing



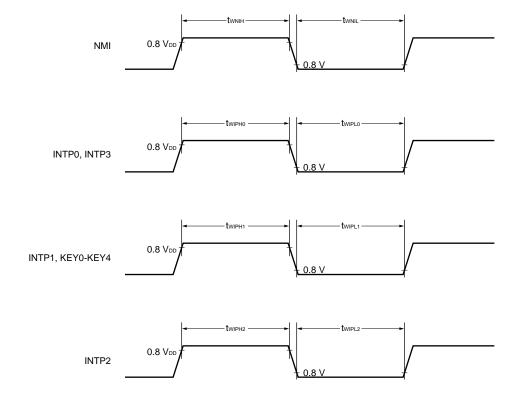
Caution When an external clock is selected as the serial clock, do not use the busy control or strobe control.



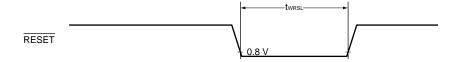
### Super timer unit input timing



# Interrupt input timing

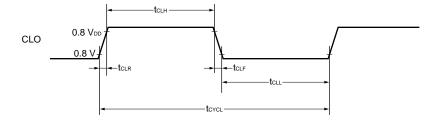


### Reset input timing



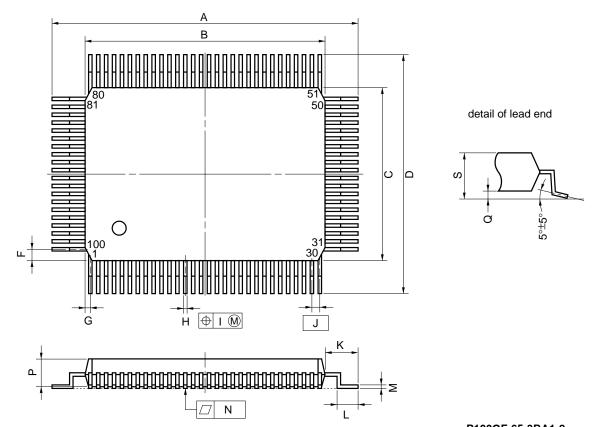


# Clock output timing



### 7. PACKAGE DRAWING

# 100 PIN PLASTIC QFP (14 $\times$ 20)



### NOTE

Each lead centerline is located within 0.15 mm (0.006 inch) of its true position (T.P.) at maximum material condition.

#### Remark

External Dimensions of the ES version are the same as those of the mass-produced version.

		P100GF-65-3BA1-2
ITEM	MILLIMETERS	INCHES
Α	23.6±0.4	0.929±0.016
В	20.0±0.2	$0.795^{+0.009}_{-0.008}$
С	14.0±0.2	$0.551^{+0.009}_{-0.008}$
D	17.6±0.4	0.693±0.016
F	0.8	0.031
G	0.6	0.024
Н	0.30±0.10	$0.012^{+0.004}_{-0.005}$
I	0.15	0.006
J	0.65 (T.P.)	0.026 (T.P.)
K	1.8±0.2	$0.071^{+0.008}_{-0.009}$
L	0.8±0.2	$0.031^{+0.009}_{-0.008}$
М	0.15 <sup>+0.10</sup> <sub>-0.05</sub>	$0.006^{+0.004}_{-0.003}$
N	0.10	0.004
Р	2.7	0.106
Q	0.1±0.1	0.004±0.004
S	3.0 MAX.	0.119 MAX.



#### **★ 8. RECOMMENDED SOLDERING CONDITIONS**

The conditions listed below shall be met when soldering the  $\mu$ PD784915A and 784916A.

For details of the recommended soldering conditions, refer to the NEC document **Semiconductor Device Mounting Technology Manual (C10535E)**.

For soldering methods and conditions other than those recommended below, contact your NEC sales representative.

Table 18-1. Soldering Conditions for Surface-Mount Type

 $\mu$ PD784915AGF-xxx-3BA : 100-pin plastic QFP (14 x 20 mm)  $\mu$ PD784916AGF-xxx-3BA : 100-pin plastic QFP (14 x 20 mm)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235°C, Duration: 30 sec. max. (at 210°C or above), Number of times: 3 max.	IR35-00-3
VPS	Package peak temperature: 215°C, Duration: 40 sec. max. (at 200°C or above), Number of times: 3 max.	VP15-00-3
Wave soldering	Solder bath temperature: 260°C max. Duration: 10 sec. max.  Number of times: 1  Preliminary heat temperature: 120°C max.  (Package surface temperature)	WS60-00-1
Partial heating	Pin temperature: 300°C max., Duration: 3 sec. max. (per device side)	-

Caution Using more than one soldering method should be avoided (except in the case of partial heating).



### APPENDIX A. DEVELOPMENT TOOLS

The following development tools are available for system development using the  $\mu$ PD784916A.

### **Language Processing Software**

RA78K4Note 1	78K/IV Series common assembler package
CC78K4Note 1	78K/IV Series common C compiler package
CC78K4-LNote 1	78K/IV Series common C compiler library source file

### **PROM Writing Tools**

PG-1500	PROM programmer
PA-78P4916GF	PROM programmer adapter connected to PG-1500
PG-1500 controller Note 2	PG-1500 control program

### **Debugging Tools**

IE-784000-R	78K/IV Series common in-circuit emulator
IE-784000-R-BK	78K/IV Series common break board
IE-784000-R-EM	78K/IV Series common emulation board
IE-784915-R-EM1	$\mu$ PD784915 Subseries evaluation emulation board
IE-78000-R-SV3	Interface adapter and cable when an EWS is used as the host machine
IE-70000-98-IF-B	Interface adapter when PC-9800 Series (except notebook PC) is used as the host
	machine
IE-70000-98N-IF	Interface adapter and cable when PC-9800 Series notebook PC is used as the host
	machine
IE-70000-PC-IF-B	Interface adapter when IBM PC/AT™ is used as the host machine
EP-784915GF-R	$\mu$ PD784915 Subseries common emulation probe
EV-9200GF-100	Conversion socket to be mounted on a target system board made for 100-pin plastic
	QFP (GF-3BA)
SM78K4Note 3	78K/IV series common system simulator
ID78K4Note 3	IE-784000-R integrated debugger
DF784915 <sup>Note 4</sup>	$\mu$ PD784915 Subseries common device file

### Real-time OS

RX78K/IV <sup>Note 4</sup>	78K/IV Series common real-time OS
MX78K4Note 2	78K/IV Series common OS

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- Notes 1. PC-9800 Series (MS-DOS™) based
  - IBM PC/AT and compatibles (PC DOS™, Windows™, MS-DOS, IBM DOS™) based
  - HP9000 Series 700™ (HP-UX™) based
  - SPARCstation<sup>™</sup> (SunOS<sup>™</sup>) based
  - NEWS<sup>™</sup> (NEWS-OS<sup>™</sup>) based
  - 2. PC-9800 Series (MS-DOS) based
    - IBM PC/AT and compatibles (PC DOS, Windows, MS-DOS, IBM DOS) based
  - 3. PC-9800 Series (MS-DOS + Windows) based
    - IBM PC/AT and compatibles (PC DOS, Windows, MS-DOS, IBM DOS) based
    - HP9000 Series 700 (HP-UX) based
    - SPARCstation (SunOS) based
  - 4. PC-9800 Series (MS-DOS) based
    - IBM PC/AT and compatibles (PC DOS, Windows, MS-DOS, IBM DOS) based
    - HP9000 Series 700 (HP-UX) based
    - SPARCstation (SunOS) based

Remark The RA78K4, CC78K4, SM78K4, and ID78K4 are used in combination with DF784915.



### APPENDIX B. RELATED DOCUMENTS

### Documents related to devices

Document Name	Document Number	
Document Name	Japanese	English
μPD784915 Subseries User's manual - Hardware	U10444J	U10444E
μPD784915 Data Sheet	U11044J	U11044E
μPD784915A, 784916A Data Sheet	U11022J	This document
μPD78P4916 Data Sheet	U11045J	U11045E
μPD784915 Subseries Appllication Note	U11361J	U11361E
$\mu$ PD784915 Subseries Special function register table	U10976J	_
78K/IV Series User's manual - Instruction	U10905J	U10905E
78K/IV Series Instruction table	U10594J	_
78K/IV Series Instruction set	U10595J	_
78K/IV Series Application note - Software fundamental	U10095J	U10095E

### Documents related to development tools (user's manual)

Document Name		Document Number	
		Japanese	English
RA78K Series Assembler package	Language	U11162J	U11162E
	Operation	U11334J	U11334E
RA78K Series Structured assembler preprocessor		U11743J	U11743E
CC78K4 Series	Language	EEU-961	_
	Operation	EEU-960	_
CC78K Series Library source file		U12322J	_
PG-1500 PROM Programmer		U11940J	EEU-1335
PG-1500 Controller PC-9800 Series (MS-DOS) based		EEU-704	EEU-1291
PG-1500 Controller IBM PC Series (PC DOS) based		EEU-5008	U10540E
IE-784000-R		EEU-5004	EEU-1534
IE-784915-R-EMI		U10931J	_
SM78K4 System Simulator Windows™ based	Reference	U10093J	U10093E
SM78K Series System Simulator	External parts user	U10092J	U10092E
	open interface		
	specifications		
ID78K4 Integrated debugger - PC-9801, 9821 Series (Windows) based	Reference	U10440J	U10440E
ID78K4 Integrated debugger - HP9000 Series 700 (HP-UX) based	Reference	U11960J	_

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### Documents related to embedded software (user's manual)

Document Name		Document Number	
		Japanese	English
RX78K/IV Real-time OS	Basics	U10603J	U10603E
	Installation	U10604J	U10604E
	Debugger	U10364J	_
78K/IV Series OS MX78K4	Fundamental	U11779J	_

Caution The documents listed above are subject to change without notice. Be sure to use the latest version of each document for designing.

#### Other related documents

Document Name	Document Number	
Document Name	Japanese	English
IC package Manual	C10943X	
Semiconductor Device Mounting Technology Manual	C10535J	C10535E
Quality Grades on NEC Semiconductor Devices	C11531J	C11531E
NEC Semiconductor Device Reliability/Quality Control System	C10983J	C10983E
Electrostatic Discharge (ESD) Test	MEM-539	_
Semiconductor Devices Quality Guarantee Guide	C11893J	MEI-1202
Microcomputer Product Series Guide	U11416J	_

Caution The documents listed above are subject to change without notice. Be sure to use the latest version of each document for designing.

[MEMO]

### **NOTES FOR CMOS DEVICES -**

## (1) PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note: Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

# (2) HANDLING OF UNUSED INPUT PINS FOR CMOS

Note: No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS device behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

# **③** STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note: Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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- · Device availability
- · Ordering information
- · Product release schedule
- · Availability of related technical literature
- Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
- · Network requirements

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